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| 1 | BRS  |      |      | (cmp or ( "chemical<br>mechanical" adj (polish\$3 or<br>planariz\$5))) and phosphonic | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/05/12<br>10:29 |          |                 | 0      |
| 2 | BRS  | L8   | 45   | 1 and 438/\$.ccls.  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/05/12<br>10:30 |          |                 | 0      |
| 3 | BRS  | L15  | 13   | @pd<=20001011 and 8   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/05/12<br>10:31 |          |                 | 0      |
| 4 | BRS  | L87  | 0    | phosphonomethyliminodiacet<br>ic and 1  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/05/12<br>11:54 |          |                 | 0      |
| 5 | BRS  | L94  | 142  | phosphonomethyliminodiacet<br>ic  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/05/12<br>11:49 |          |                 | 0      |
| 6 | BRS  | L101 | 0    | "N-phosphonomethyliminodia cetic acid" and cmp  | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/05/12<br>11:51 |          | ·               | 0      |
| 7 | BRS  | L108 | 1    | cetic acid" and polisn\$3   | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB |                     |          |                 | 0      |
| 8 | BRS  | L115 | 0    | "N-phosphonomethyliminodia cetic acid" and planariz\$5\$3                             | USPAT;<br>US-PGPUB;<br>EPO; JPO;<br>DERWENT;<br>IBM_TDB | 2003/05/12<br>11:53 |          |                 | 0      |

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NEWS 9 Sep 16 CA Section Thesaurus available in CAPLUS and CA
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NEWS 16 Dec 17 PCTFULL now covers WP/PCT Applications from 1978 to date
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NEWS 19 Jan 29
                 Simultaneous left and right truncation added to COMPENDEX,
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NEWS 32 Apr 14 MEDLINE Reload
NEWS 33 Apr 17
                Polymer searching in REGISTRY enhanced
NEWS 34 Apr 21 Indexing from 1947 to 1956 being added to records in CA/CAPLUS
NEWS 35 Apr 21 New current-awareness alert (SDI) frequency in
                 WPIDS/WPINDEX/WPIX
NEWS 36 Apr 28
                 RDISCLOSURE now available on STN
NEWS 37
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                 Pharmacokinetic information and systematic chemical names
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E3 0 --> AMINOTRIMETHYLENEPHOSPHONIC/CN

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       1998:85866 USPATFULL
TΙ
       Multi-oxidizer slurry for chemical mechanical polishing
IN
       Kaufman, Vlasta Brusic, Geneva, IL, United States
       Wang, Shumin, Naperville, IL, United States
PΑ
       Cabot Corporation, Boston, MA, United States (U.S. corporation)
PT
       US 5783489
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ΑI
       US 1996-718937
                               19960924 (8)
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       US 3385682
                        May 1968
                                                Lowen
       US 3668131
                        Jun 1972
                                                Banush et al.
       US 4671851
                        Jun 1987
                                                Beyer et al.
       US 4789648
                        Dec 1988
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       US 4818333
                        Apr 1989
                                                Michaud
       US 4910155
                        Mar 1990
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       US 4944836
                        Jul 1990
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                        Sep 1990
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                        Sep 1990
      US 4956313
                                                Cote et al.
      US 4992135
                        Feb 1991
                                                Doan
       US 5137544
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                        Sep 1993
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                        Oct 1993
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                                               Rostoker et al.
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                        Apr 1995
                                               Danielson et al.
      US 5476606
                        Dec 1995
                                               Brancaleoni
      US 5527423
                        Jun 1996
                                                Neville et al.
       US 5540810
                        Jul 1996
                                                Sandhu et al.
      US 5575837
                        Nov 1996
                                                Kodama et al.
EXNAM Primary Examiner: Jones, Deborah
      Number of Claims: 38
CLMN
ECL
       Exemplary Claim: 1
DRWN
      No Drawings
      A chemical mechanical polishing slurry comprising at least two oxidizing
AΒ
       agents, an organic acid and an abrasive and a method for using the
       chemical mechanical polishing slurry to remove titanium, titanium
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nitride, and an aluminum alloy containing layer from a substrate.

SUMM BACKGROUND OF THE INVENTION

### 1. Field of the Invention

This invention concerns a chemical mechanical polishing slurry including at least two oxidizers. The chemical mechanical polishing slurry is useful for polishing metal layers and thin-films associated with semiconductor manufacturing. More particularly this invention concerns a chemical mechanical polishing slurry that is especially adapted for polishing multiple metal layers and thin-films where one of the layers or films is comprised of aluminum or an aluminum containing alloy and another layer or thin film is comprised of titanium or a titanium containing alloy such as titanium nitride.

### 2. Description of the Art

Integrated circuits are made up of millions of active devices formed in or on a silicon substrate. The active devices, which are initially isolated from one another, are interconnected to form functional circuits and components. The devices are interconnected through the use of well-known multilevel interconnections. Interconnection structures normally have a first layer of metallization, an interconnection layer, a second level of metallization, and sometimes a third and subsequent level of metallization. Interlevel dielectrics such as doped and undoped silicon dioxide (SiO.sub.2), are used to electrically isolate the different levels of metallization in a silicon substrate or well. The electrical connections between different interconnection levels are made through the use of metallized vias. U.S. Pat. No. 4,789,648, which is incorporated herein by reference, describes a method for preparing multiple metallized layers and metallized vias in insulator films. In a similar manner, metal contacts are used to form electrical connections between interconnection levels and devices formed in a well. The metal vias and contacts may be filled with various metals and alloys including titanium (Ti), titanium nitride (TiN), tantalum (Ta), aluminum copper (Al--Cu), aluminum silicon (Al--Si), copper (Cu), tungsten (W), and combinations thereof. The metal vias and contacts generally employ an adhesion layer such as titanium nitride (TiN) and/or titanium (Ti) to adhere the metal layer to the SiO.sub.2 substrate. At the contact level, the adhesion layer acts as a diffusion barrier to prevent the filled metal and SiO.sub.2 from reacting.

In one semiconductor manufacturing process, metallized vias or contacts are formed by a blanket metal deposition followed by a chemical mechanical polish (CMP) step. In a typical process, via holes are etched through an interlevel dielectric (ILD) to interconnection lines or to a semiconductor substrate. Next, a thin adhesion layer such as titanium nitride and/or titanium is generally formed over the ILD and is directed into the etched via hole. Then, a metal film is blanket deposited over the adhesion layer and into the via hole. Deposition is continued until the via hole is filled with the blanket deposited metal. Finally, the excess metal is removed by chemical mechanical polishing, (CMP) to form metal vias. Processes for manufacturing and/or CMP of ILD's are disclosed in U.S. Pat. Nos. 4,671,851, 4,910,155 and 4,944,836.

In a typical chemical mechanical polishing process, the substrate is placed in direct contact with a rotating polishing pad. A carrier applies pressure against the backside of the substrate. During the polishing process, the pad and table are rotated while a downward force is maintained against the substrate back. An abrasive and chemically reactive solution, commonly referred to as a "slurry" is applied to the pad during polishing. The slurry initiates the polishing process by chemically reacting with the film being polished. The polishing process is facilitated by the rotational movement of the pad relative to the

substrate as slurry is provided to the wafer/pad interface. Polishing is continued in this manner until the desired film on the insulator is removed.

The slurry composition is an important factor in the CMP step. Depending on the choice of the oxidizing agent, the abrasive, and other useful additives, the polishing slurry can be tailored to provide effective polishing to metal layers at desired polishing rates while minimizing surface imperfections, defects and corrosion and erosion. Furthermore, the polishing slurry may be used to provide controlled polishing selectivities to other thin-film materials used in current integrated circuit technology such as titanium, titanium nitride and the like.

Typically CMP polishing slurries contain an abrasive material, such as silica or alumina, suspended in an oxidizing, aqueous medium. For example, U.S. Pat. No. 5,244,534 to Yu et al. reports a slurry containing alumina, hydrogen peroxide, and either potassium or ammonium hydroxide that is useful to remove tungsten at predictable rates with little removal of the underlying insulating layer. U.S. Pat. No. 5,209,816 to Yu et al. discloses a slurry comprising perchloric acid, hydrogen peroxide and a solid abrasive material in an aqueous medium that is useful for polishing aluminum. U.S. Pat. No. 5,340,370 to Cadien and Feller discloses a tungsten polishing slurry comprising approximately 0.1M potassium ferricyanide, approximately 5 weight percent silica and potassium acetate. Acetic acid is added to buffer the pH at approximately 3.5.

U.S. Pat. No. 4,789,648 to Beyer et al. discloses a slurry formulation using alumina abrasives in conjunction with sulfuric, nitric, and acetic acids and deionized water. U.S. Pat. Nos. 5,391,258 and 5,476,606 disclose slurries for polishing a composite of metal and silica which includes an aqueous medium, abrasive particles and an anion which controls the rate of silica removal. Other polishing slurries for use in CMP applications are described in U.S. Pat. No. 5,527,423 to Neville et al., U.S. Pat. No. 5,354,490 to Yu et al., U.S. Pat. No. 5,340,370 to Cadien et al., U.S. Pat. No. 5,209,816 to Yu et al., U.S. Pat. No. 5,157,876 to Medellin, U.S. Pat. No. 5,137,544 to Medellin, and U.S. Pat. No. 4,956,313 to Cote et al.

It has been recognized that CMP slurries that are used to polish multiple metal layers in a single step typically exhibit a low polishing rate towards at least one of the metal layers. As a result, the polishing step is lengthened or operated at aggressive polishing conditions that can cause undesirable erosion of the SiO.sub.2 layer and recessing of the metal vias and/or metal lines. Such recessing causes a non-planar via layer or metal line layer to be formed which impairs the ability to print high resolution lines during subsequent photolithography steps and can cause the formation of voids or open circuits in the formed metal interconnections. Additionally, recessing increases when over polishing is used to ensure complete removal of the titanium, titanium nitride, and aluminum films across the surface of a wafer. Thus, a need remains for CMP slurries which reliably polish a plurality of metal layers including a titanium layer in an integrated circuit. Accordingly, a new CMP polishing slurry that polishes titanium at a higher rate is needed to overcome the present substrate manufacturing reliability issues.

## SUMMARY OF THE INVENTION

The present invention is directed to a single chemical mechanical polishing slurry that is able to polish aluminum alloy, titanium, and titanium nitride layers at acceptable rates.

In addition, the chemical mechanical polishing slurry has a low insulator polishing selectivity while exhibiting high polishing selectivities towards titanium, titanium nitride, and aluminum.

Furthermore, this invention is directed to methods for using a single chemical mechanical polishing slurry to polish a plurality of metal layers in an integrated circuit.

In one embodiment, this invention is an aqueous chemical mechanical polishing slurry. The chemical mechanical polishing slurry comprises an abrasive, from about 0.2 to about 10.0 weight percent of a first oxidizer, from about 0.5 to about 10.0 weight percent of a second oxidizer, and from about 0.5 to about 3.0 weight percent of at least one organic acid. The chemical mechanical polishing slurry should have a pH of from about 2.0 to about 8.0.

In another embodiment, this invention is an aqueous chemical mechanical polishing slurry. The chemical mechanical polishing slurry comprises alumina, from about 0.2 to about 10.0 weight percent ammonium persulfate, from about 0.5 to about 10.0 weight percent hydrogen peroxide, and from about 0.5 to about 3.0 succinic acid. Furthermore, the pH of the chemical mechanical polishing slurry ranges from about 2.0 to about 8.0.

In still another embodiment, this invention is a method for polishing a substrate. The method includes admixing an abrasive, from about 0.2 to about 10.0 weight percent of a first oxidizer, from about 0.5 to about 10.0 weight percent of a second oxidizer, from about 0.5 to about 3.0 weight percent of at least one organic acid, and deionized water to give a chemical mechanical polishing slurry. Next, the chemical mechanical polishing slurry is applied to the substrate and at least a portion of a titanium layer, at least a portion of a titanium nitride adhesion layer and at least a portion of an aluminum alloy containing layer associated with the substrate are removed by bringing a pad into contact with the substrate and moving the pad in relation to the substrate.

# DETD DESCRIPTION OF THE CURRENT EMBODIMENT

The present invention relates to a chemical mechanical polishing slurry that comprises an abrasive and at least two oxidizers. The chemical mechanical polishing slurry is used to polish at least one metal layer associated with a substrate selected from the group including integrated circuits, thin films, multiple level semiconductors, and wafers. In particular, the chemical mechanical polishing slurry of this invention has been found to exhibit excellent polishing selectivities when used to polish a substrate including titanium, titanium nitride, and aluminum alloy containing layers in a single step, multiple metal layer chemical mechanical polishing process.

Before describing the details of the various preferred embodiments of this invention, some of the terms that are used herein will be defined. The chemical mechanical polishing slurry, ("CMP slurry"), is a useful product of this invention that comprises an at least two oxidizing agents, an abrasive, an organic acid, and other optional ingredients. The CMP slurry is useful for polishing a multiple level metallization which may include but are not limited to semiconductor thin-films, integrated circuit thin-films, and for any other films and surfaces where CMP processes are useful. The terms "aluminum" and "aluminum containing alloys" are used interchangeably herein as it is within the understanding of one of skill in the art that pure aluminum is a poor

conductor and that most "aluminum" containing metallization layers are actually comprised of an aluminum containing alloy, such as Al--Cu, that are good conductors.

The oxidizing agents useful in the chemical mechanical polishing slurry are incorporated into a CMP slurry to aid in oxidizing the multiple metal layers to their corresponding oxide, hydroxide, or ions. For example, in the present invention, the oxidizing agents may be used to oxidize a metal layer to its corresponding oxide or hydroxide, e.g., titanium to titanium oxide, tungsten to tungsten oxide, copper to copper oxide, and aluminum to aluminum oxide. The oxidizing agents of this invention are useful when incorporated into a polishing slurry to polish metals and metal based components including titanium, titanium nitride, tantalum, copper, tungsten, aluminum, and aluminum alloys such as aluminum/copper alloys, and various mixtures and combinations thereof by mechanically polishing the metals to remove the respective oxide layer.

The CMP slurry of this invention includes at least two oxidizers. The first oxidizer is selected from peroxy compounds which may disassociate through hydroxy radicals. Such oxidizers exhibit good polishing selectivity towards titanium. Non-exclusive examples of such peroxy compounds include peracetic acid, urea hydrogen peroxide, sodium peroxide, perboric acid, sodium percarbonate, and hydrogen peroxide, with hydrogen peroxide being the preferred first oxidizer. The first oxidizer may be present in the overall chemical mechanical polishing slurry in an amount ranging from about 0.5 to about 10.0 weight percent. It is preferred that the first oxidizer is present in the slurry in an amount ranging from about 1.0 to about 6.0 weight percent and most preferably from about 2.0 to about 4.0 weight percent.

The CMP slurry of this invention includes a second oxidizer. The second oxidizer should be capable of CMP polishing of aluminum and aluminum containing alloy metal layers with good selectivities. The second oxidizer is selected from dipersulfate and monopersulfate compounds. Ammonium persulfate is a preferred second oxidizer. The second oxidizer may be present in the chemical mechanical polishing slurry in an amount ranging from about 0.2 to about 10.0 weight percent. More preferably, the second oxidizer will be present in the chemical mechanical polishing slurry in an amount ranging from about 2.0 to about 8.0 weight percent with a range of from about 3.0 to about 5.0 being most preferred.

The CMP slurry of this invention includes an abrasive. The abrasive is typically a metal oxide abrasive. The metal oxide abrasive may be selected from the group including alumina, titania, zirconia, germania, silica, ceria and mixtures thereof. The CMP slurry of this invention preferably includes from about 1.0 to about 9.0 weight percent or more of an abrasive. It is more preferred, however, that the CMP slurry of this invention includes from about 3.0 to about 6.0 weight percent abrasive.

The metal oxide abrasive may be produced by any techniques known to those skilled in the art. Metal oxide abrasives can be produced using any high temperature process such as sol-gel, hydrothermal or, plasma process, or by processes for manufacturing fumed or precipitated metal oxides. Preferably, the metal oxide is a fumed or precipitated abrasive and, more preferably it is a fumed abrasive such as fumed silica or fumed alumina. For example, the production of fumed metal oxides is a well-known process which involves the hydrolysis of suitable feedstock vapor (such as aluminum chloride for an alumina abrasive) in a flame of hydrogen and oxygen. Molten particles of roughly spherical shapes are formed in the combustion process, the diameters of which are varied through process parameters. These molten spheres of alumina or similar

oxide, typically referred to as primary particles, fuse with one another by undergoing collisions at their contact points to form branched, three dimensional chain-like aggregates. The force necessary to break aggregates is considerable and often considered irreversible. During cooling and collecting, the aggregates undergo further collision that may result in some mechanical entanglement to form agglomerates. Agglomerates are thought to be loosely held together by van der Waals forces and can be reversed, i.e., de-agglomerated, by proper dispersion in a suitable media.

Precipitated abrasives may be manufactured by conventional techniques such as by coagulation of the desired particles from an aqueous medium under the influence of high salt concentrations, acids or other coagulants. The particles are filtered, washed, dried and separated from residues of other reaction products by conventional techniques known to those skilled in the art.

A preferred metal oxide will have a surface area, as calculated from the method of S. Brunauer, P. H. Emmet, and I. Teller, J. Am. Chemical Society, Volume 60, Page 309 (1938) and commonly referred to as BET, ranging from about 5 m.sup.2 /g to about 430 m.sup.2 /g and preferably from about 30 m.sup.2 /g to about 170 m.sup.2 /g. Due to stringent purity requirements in the IC industry the preferred metal oxide should be of a high purity. High purity means that the total impurity content, from sources such as raw material impurities and trace processing contaminants, is typically less than 1% and preferably less than 0.01% (i.e., 100 ppm).

In this preferred embodiment, the metal oxide abrasive consists of metal oxide aggregates having a size distribution less than about 1.0 micron, a mean aggregate diameter less than about 0.4 micron and a force sufficient to repel and overcome the van der Waals forces between abrasive aggregates themselves. Such metal oxide abrasive has been found to be effective in minimizing or avoiding scratching, pit marks, divots and other surface imperfections during polishing. The aggregate size distribution in the present invention may be determined utilizing known techniques such as transmission electron microscopy (TEM). The mean aggregate diameter refers to the average equivalent spherical diameter when using TEM image analysis, i.e., based on the cross-sectional area of the aggregate. By force is meant that either the surface potential or the hydration force of the metal oxide particles must be sufficient to repel and overcome the van der Waals attractive forces between the particles.

In another preferred embodiment, the metal oxide abrasive may consist of discrete, individual metal oxide particles having a primary particle diameter less than 0.4 micron (400 nm) and a surface area ranging from about 10 m.sup. 2 / q to about 250 m.sup. 2 / q.

Preferably, the metal oxide abrasive is incorporated into the aqueous medium of the polishing slurry as a concentrated aqueous dispersion of metal oxides, which aqueous dispersion of metal oxide abrasives typically ranges from about 3% to about 45% solids, and preferably between 10% and 20% solids. The aqueous dispersion of metal oxides may be produced utilizing conventional techniques, such as slowly adding the metal oxide abrasive to an appropriate media, for example, deionized water, to form a colloidal dispersion. The dispersion is typically completed by subjecting it to high shear mixing conditions known to those skilled in the art. The pH of the slurry may be adjusted away from the isoelectric point to maximize colloidal stability.

The CMP slurry of this invention includes an organic acid. A wide range

of conventional organic acids, salts of organic acids, and mixtures thereof are useful in the CMP slurry of the present invention to enhance the selectivity to oxide polishing rate, such as monofunctional acids, di-functional acids, hydroxyl/carboxylate acids, chelating, non-chelating acids, and their salts. Preferably, the organic acid is selected from the group of acetic acid, adipic acid, butyric acid, capric acid, caproic acid, caprylic acid, citric acid, glutaric acid, glycolic acid, formic acid, fumaric acid, lactic acid, lauric acid, malic acid, maleic acid, malonic acid, myristic acid, oxalic acid, palmitic acid, phthalic acid, propionic acid, pyruvic acid, stearic acid, succinic acid, tartaric acid, valeric acid and derivatives, including salts thereof.

The organic acid or salt should be present in the final CMP slurry, individually or in combination with other organic acids or salts, in an amount sufficient to enhance the oxide selectivity without detrimentally effecting the stability of the CMP slurry. As such, the organic acid is typically present in the slurry from about 0.05% to 15% by weight, and preferably in a range between 0.5% and 5.0% by weight. Examples of chemical mechanical polishing slurries including organic acids and salts thereof are disclosed in U.S. Pat. Application Ser. No. 08/644,509 which is incorporated herein by reference. A preferred organic acid is succinic acid. Succinic acid has been found to promote passivation of aluminum and it also inhibits the removal of the dielectric layer.

Other well known polishing slurry additives may be incorporated into the chemical mechanical polishing slurry of this invention. One type of optional additives are inorganic acids and/or salts thereof which may be added to the polishing slurry to further improve or enhance the polishing rate of the barrier layers in the wafer, such as titanium and tantalum. Useful inorganic additives include sulfuric acid, phosphoric acid, nitric acid, ammonium salts, potassium salts, sodium salts or other cationic salts of sulfates and phosphates.

In order to promote stabilization of the polishing slurry including oxidizing agents against settling, flocculation and decomposition, a variety of optional additives, such as surfactants, stabilizers, or dispersing agents, can be used. If a surfactant is added to the CMP slurry, then it can be an anionic, cationic, nonionic, or amphoteric surfactant or a combination of two or more surfactants can be employed. Furthermore, it has been found that the addition of a surfactant may be useful to improve the within-wafer-non-uniformity (WIWNU) of the wafers, thereby improving the surface of the wafer and reducing wafer defects. Non-limiting examples of preferred stabilizers useful in the CMP slurry of this invention include but are not limited to phosphonic acids such as aminotri(methylenephosphonic) acid, 1-hydroxyethylidene-4diphosphonic acid, hexamethylenediaminetetramethylene phosphonic acid, and diethylenetetramine pentamethylenephosphonic acid. One or more stabilizers may be present in the CMP slurry of this invention in an amount that is sufficient to produce measurable improvements in slurry stability, and generally in an amount ranging from about 100 ppm to about 5.0 weight percent.

In general, the amount of additive such as a surfactant that may be used in the present invention should be sufficient to achieve effective stearic stabilization of the slurry and will typically vary depending on the particular surfactant selected and the nature of the surface of the metal oxide abrasive. For example, if not enough of a selected surfactant is used, it will have little or no effect on stabilization. On the other hand, too much surfactant in the CMP slurry may result in undesirable foaming and/or flocculation in the slurry. As a result, stabilizers such as surfactants should generally be present in a range

between about 0.001% and 10% by weight. Furthermore, the additive may be added directly to the slurry or treated onto the surface of the metal oxide abrasive utilizing known techniques. In either case, the amount of additive is adjusted to achieve the desired concentration in the polishing slurry.

Stabilizers most useful in the CMP slurry of this invention are phosphonic acids and salts thereof. A most preferred phosphonic acid stabilizer is aminotrimethylene phosphonic acid. A phosphonic acid stabilizer may be present in the CMP slurry of this invention in an amount ranging from about 0.01 to about 5.0 weight percent. The addition of one or more phosphonic acids to the CMP slurry of this invention may also inhibit metallic corrosion.

It is desirable to maintain the pH of the CMP slurry of this invention within a range of from about 2.0 to about 8, and preferably between from about 3.5 to about 6 in order to facilitate control of the CMP process. Specifically, it has been observed that the metal surface film passivation capability of the CMP slurry of this invention is compromised at high pH's, e.g., greater than 8. Likewise, slurry handling problems and substrate polishing quality problems are encountered when the pH of the CMP slurry of this invention is too low, e.g., less than 2. The pH of the CMP slurry of this invention may be adjusted using any known acid, base, or amine. However, the use of an acid or base that contains no metal ions, such as ammonium hydroxide and amines, or nitric, phosphoric, sulfuric, or organic acids are preferred to avoid introducing undesirable metal components into the CMP slurry of this invention.

The chemical mechanical polishing slurry of this invention has been found to have a high titanium (Ti) polishing rate as well as a high polishing rates towards titanium nitride (TiN) an aluminum containing layer and especially towards an Al--Cu metal layer. In addition, the chemical mechanical polishing slurry exhibits desirable low polishing rates towards the dielectric insulating layer.

One important application for the chemical mechanical polishing slurry of this invention is as a chemical mechanical polish for thin layer films comprising titanium, aluminum and aluminum containing alloys such as Al--Cu. In such a polishing application, the single polishing slurry is effective to polish titanium, titanium nitride, and aluminum alloy containing layers. The CMP slurry of this invention preferably exhibit a Al--Cu to titanium [Al--Cu:Ti] polishing selectivity and a Al--Cu to TiN [Al--Cu:TiN] polishing selectivity of from about 2:1 to about 1:2 and preferably from about 1:1.25 to about 1.25:1. At the same time the CMP slurry of this invention exhibits a very low dielectric (SiO.sub.2) polishing rate and preferably an SiO.sub.2 polishing rate less than 40.ANG./min.

The CMP slurry may be produced using conventional techniques known to those skilled in the art. Typically, the oxidizing agent and any optional additives, are mixed into the aqueous medium, such as deionized or distilled water, at pre-determined concentrations under low shear conditions until such components are completely dissolved in the medium. A concentrated dispersion of the metal oxide abrasive, such as fumed alumina, is added to the medium and diluted to the desired loading level of abrasive in the final CMP slurry.

The CMP slurries of the present invention may be supplied as one package system (oxidizing agents, abrasive, and additives in a stable aqueous medium). To avoid possible CMP slurry degradation, however, it is preferred that at least a two package system is used where the first

package comprises the first oxidizer and the second package comprises the second oxidizer. The remaining components, the abrasive, the organic acid, and any optional additives may be placed in either the first container, the second container or in a third container. Furthermore, the components in the first container or second container may be in dry form while the components in the corresponding container are in the form of an aqueous dispersion. For example, the first container may comprise the first oxidizer in aqueous form while the second container comprises an aqueous dispersion of the abrasive the second oxidizer and the organic acid. Alternately, the first container may comprise an aqueous dispersion of an abrasive and the first oxidizer while the second container may comprise the organic acid and the second oxidizer in aqueous form. Other two-container combinations of the ingredients of the CMP slurry of this invention are within the knowledge of one having ordinary skill in the art. It is preferred that the first oxidizer and the second oxidizer are held in separate containers as they may degrade over time when combined unless they are stored at low temperatures, e.g., 10.degree. C. or less.

A multi-package CMP slurry system may be used with any standard polishing equipment appropriate for use on the desired metal layer of the wafer. The multi-package system includes one or more CMP slurry components in aqueous or dry form in two or more containers. The multi-package system is used by combining the components from the various containers in the desired amounts to give a CMP slurry comprising at least two oxidizing agents, an abrasive, and an organic acid in amounts described above.

The CMP slurry of the present invention does not significantly increase the silicon dioxide polishing rate above about 40.ANG./min. However, the CMP slurry of this invention significantly increases the polishing rate of titanium or titanium nitride while maintaining a high polishing rate towards aluminum and aluminum containing alloys such as Al--Cu. Thus, the CMP slurry of this invention is effective in controlling polishing selectivities of titanium, titanium nitrite and Al--Cu. The polishing slurry of the present invention may be used during the various stages of semiconductor integrated circuit manufacture to provide effective polishing at desired polishing rates while minimizing surface imperfections and defects.

# EXAMPLES

We have discovered that a CMP slurry including two oxidizers is capable of polishing a multiple metal layer comprising titanium, titanium nitride, and Al--Cu at high rates while exhibiting an acceptable low polishing rate towards the dielectric layer.

The following examples illustrate preferred embodiments of this invention as well as preferred methods for using compositions of this invention.

## Example 1

In this example, CMP polishing was accomplished using two CMP slurries including 4.0 weight percent ammonium persulfate, 3.0 weight percent succinic acid, 5.0 weight percent of a fumed alumina abrasive, WA-355, manufactured by the Microelectronics Materials Division of Cabot Corporation, in Tuscola, Ill. and sold under the trademark SEMI-SPERSE.RTM., and either 0 or 3.0 weight percent hydrogen peroxide with the remainder of the slurry consisting of deionized water. The slurry was adjusted to a pH of 5.0 with ammonium hydroxide.

The CMP slurry was applied to Ti coated blanket wafers. The wafers were placed in an IPEC 472 tool manufactured by IPEC Planar. The wafers were subjected to 5 psi down force, a table speed of 45 rpm, and a spindle speed of 60 rpm. The CMP slurry was applied to a XMGH 1158 pad manufactured by Rodel, Inc. at a rate of 200 ml/min.

The titanium removal rate for the CMP slurry containing no hydrogen peroxide was 8.6 nm/min and the titanium/Al--Cu selectivity was 40.7. The titanium removal rate for the CMP slurry containing 3.0 weight percent hydrogen peroxide was 200 nm/min and the titanium/Al--Cu selectivity was 1:1. In both tests the Al--Cu removal rate was about 200 nm/min.

## Example 2

This example studies the effect of varying solution pH on the aluminum polishing rates and Ti, TiN, and SiO.sub.2 selectivities of a CMP slurry of this invention. This example used a CMP slurry of this invention having the following composition; 4.0 weight percent ammonium persulfate; 3.0 weight percent succinic acid; 3.0 weight percent hydrogen peroxide; 5.0 weight percent alumina abrasive (WA-355) with the remainder being deionized water. The pH of the slurry was adjusted using ammonium hydroxide to give two slurries; the first with a pH of 3.5 and the second with a pH of 5.0.

The CMP slurry was applied to Al, Ti, TiN, and SiO.sub.2 blanket coated wafers. The wafers were placed in a IPEC 472 tool and polished using a 5 psi down force, a table speed of 45 rpm, and a spindle speed of 60 rpm. The CMP slurry was applied to a XMGH1158 pad at a rate of 200 ml/min. Table 1, below summarizes the results of this example.

TABLE 1

|                 | pH 3.5    | pH 5.0     |
|-----------------|-----------|------------|
|                 |           |            |
| Al removal rate | :         |            |
|                 | 350 nm/mi | n          |
|                 |           | 600 nm/min |
| Al WIWNU        | 7.6%      | 14%        |
| Sel. to Ti      | 1.72:1    | 1.61:1     |
| Sel. to TiN     | 1.79:1    | 3.9:1      |
| Sel. to SiO.sub | .2        |            |
|                 | 88:1      | n/m        |
| Dishing, 50 .mu | .m*       |            |
|                 | 57 nm     | 40.5 nm    |
| Dishing, 128 .m | u.m**     |            |
|                 | 198 nm    | 164 nm     |
| Erosion         | 65 nm     | 54 nm      |

<sup>\*</sup>the result is based on initial feature depth of 750 nm covered with 1.5 .mu.m of AlCu.

The polishing results, set forth in Table 1, above, clearly show that the CMP slurry of this invention is useful over a wide pH range.

## Example 3

This example investigates the effect of the addition of phosphonic acids to a CMP slurry of this invention on titanium dissolution. A CMP slurry consisting of 4.0 weight percent ammonium persulfate, 3.0 weight percent

<sup>\*\*</sup>the result is based on initial feature depth of 750 nm covered with 0.8 .mu.m of AlCu.

succinic acid, 3.0 weight percent hydrogen peroxide, 5.0 weight percent alumina abrasive (WA-355), and deionized water was used in this example. The CMP slurry, with and without the addition of small amounts of aminotri(methylenephosphonic acid)) was introduced into an electrochemical cell, and the Ti dissolution rate of the freshly abraded surface was evaluated by electrochemical techniques five minutes after abrasion had ceased. The results of the tests are set forth in Table 2 immediately below:

TABLE 2

| Slurry pH | % Phosphonic | Ti Dissolution<br>Acid<br>(.ANG./min) | Rate |
|-----------|--------------|---------------------------------------|------|
| 3.5       | 0            | 3.4                                   |      |
| 5.0       | 0            | 6.0                                   |      |
| 5.0       | 0.1          | 3.0                                   |      |
| 5.0       | 0.5          | 1.3                                   |      |
| 5.0       | 1.0          | 1.0                                   |      |
| 8.05      | 0            | 68                                    |      |
| 8.05      | 1.0          | 3.4                                   |      |
|           |              |                                       |      |

The results of these examples demonstrate that a CMP slurrying including a first oxidizer and a second oxidizer is useful, over a wide range of pH's in polishing multiple layers of metallization in a single polishing step. The results also demonstrate that the addition of a stabilizer to a CMP slurry of this invention inhibits corrosion of a metal layer of a metal substrate.

While the present invention has been described by means of specific embodiments, it will be understood that modifications may be made without departing from the spirit of the invention. The scope of the invention is not to be considered as limited by the description of the invention set forth in the specification and examples, but rather as defined by the following claims.

## CLM What is claimed is:

- 1. A chemical mechanical polishing slurry comprising: an aqueous medium of; an abrasive; from about 0.2 to about 10.0 weight percent of a first oxidizer; from about 0.5 to about 10.0 weight percent of a second oxidizer; and from about 0.5 to about 15.0 weight percent of at least one organic acid, wherein the pH of the chemical mechanical polishing slurry ranges from about 2.0 to about 8.0.
- 2. The chemical mechanical polishing slurry of claim 1 wherein the first oxidizer is at least one peroxy compound which may disassociate through hydroxyl radicals.
- 3. The chemical mechanical polishing slurry of claim 2 wherein the first oxidizer is hydrogen peroxide.
- 4. The chemical mechanical polishing slurry of claim 1 wherein the second oxidizer is at least one dipersulfate salt or acid or monopersulfate salt or acid.
- 5. The chemical mechanical polishing slurry of claim 4 wherein the second oxidizer is ammonium persulfate.
- 6. The chemical mechanical polishing slurry of claim 1 wherein the abrasive is a metal oxide.

- 7. The chemical mechanical polishing slurry of claim 5 wherein the metal oxide abrasive is selected from the group including alumina, ceria, germania, silica, titania, zirconia, and mixtures thereof.
- 8. The chemical mechanical polishing slurry of claim 1 wherein the abrasive is an aqueous dispersion of a metal oxide.
- 9. The chemical mechanical polishing slurry of claim 7 wherein the metal oxide abrasive consists of metal oxide aggregates having a size distribution less than about  $1.0~\rm micron$  and a mean aggregate diameter less than about  $0.4~\rm micron$ .
- 10. The chemical mechanical polishing slurry of claim 7 wherein the metal oxide abrasive consists of discrete, individual metal oxide spheres having a primary particle diameter less than 0.400 micron and a surface area ranging from about 10 m.sup.2 /g to about 250 m.sup.2 /g.
- 11. The chemical mechanical polishing slurry of claim 1 wherein the abrasive has a surface area ranging from about 5 m.sup.2 /g to about 430 m.sup.2 /g.
- 12. The chemical mechanical polishing slurry of claim 11 wherein the abrasive has a surface area of from about 30 m.sup.2 /g to about 170 m.sup.2 /g.
- 13. The chemical mechanical polishing slurry of claim 7 wherein the abrasive is selected from the group consisting of precipitated abrasives or fumed abrasives.
- 14. The chemical mechanical polishing slurry of claim 13 wherein the abrasive is selected from the group consisting of silica, alumina, and mixtures thereof.
- $15.\ {
  m The\ chemical\ mechanical\ polishing\ slurry\ of\ claim\ 1}$  wherein the organic acid is succinic acid.
- 16. The chemical mechanical polishing slurry of claim 1 further including a surfactant.
- 17. The chemical mechanical polishing slurry of claim 1 further including a stabilizer.
- 18. A chemical mechanical polishing slurry comprising: an aqueous medium; from about 1.0 to about 9.0 weight percent alumina; from about 0.5 to about 10.0 weight percent hydrogen peroxide; from about 0.2 to about 10.0 weight percent ammonium persulfate; and from about 0.5 to about 5.0 weight percent succinic acid, wherein the pH of the chemical mechanical polishing slurry ranges from about 2.0 to about 8.0.
- 19. The chemical mechanical polishing slurry of claim 18 wherein hydrogen peroxide is present in the composition in an amount ranging from about 1.0 to about 6.0 weight percent.
- 20. The chemical mechanical polishing slurry of claim 18 wherein ammonium persulfate is present in the composition in an amount ranging from about 2.0 to about 8.0 weight percent.
- 21. The chemical mechanical polishing slurry of claim 18 wherein the alumina is present in the composition in an amount ranging from about 3.0 to about 6.0 weight percent.

- 22. The chemical mechanical polishing slurry of claim 18 including from about 100 ppm to about 5.0 weight percent of a stabilizer.
- 23. The chemical mechanical polishing slurry of claim 18 having a Ti/Al--Cu selectivity of from about 1:2 to about 2:1.
- 24. A method for polishing a substrate including at least one metal layer comprising the steps of: (a) admixing, from about 1.0 to about 9.0 weight percent of an abrasive, from about 0.2 to about 10.0 weight percent of a first oxidizer, from about 0.5 to about 10.0 weight percent of a second oxidizer, from about 0.5 to about 3.0 weight percent of at least one organic acid, and deionized water to give a chemical mechanical polishing slurry; (b) applying the chemical mechanical polishing slurry to the substrate; and (c) removing at least a portion of the metal layer from the substrate by bringing a pad into contact with the substrate and moving the pad in relation to the substrate.
- 25. The method of claim 24 wherein the substrate includes a titanium adhesion layer and an aluminum alloy containing layer and wherein at least a portion of the titanium layer and at least a portion of the aluminum alloy containing layer are removed in step (c).
- 26. The method of claim 24 wherein the substrate further includes a titanium nitride layer wherein at least a portion of the titanium nitride layer is removed in step (c).
- 27. The method of claim 24 wherein the chemical mechanical polishing slurry is applied to the pad before the pad is placed into contact with the substrate.
- 28. The method of claim 24 wherein the first oxidizer is at least one peroxy compound that may disassociate through hydroxyl radicals.
- 29. The method of claim 28 wherein the first oxidizer is hydrogen peroxide.
- 30. The method of claim 24 wherein the second oxidizer is at least one dipersulfate salt or acid or monopersulfate salt or acid.
- 31. The method of claim 30 wherein the second oxidizer is ammonium persulfate.
- 32. The method of claim 24 wherein the abrasive is a metal oxide.
- 33. The method of claim 32 wherein the metal oxide abrasive is selected from the group including alumina, ceria, germania, silica, titania, zirconia, and mixtures thereof.
- 34. The method of claim 24 wherein the abrasive is an aqueous dispersion of a metal oxide.
- 35. The method of claim 34 wherein the metal oxide abrasive is selected from the group consisting of precipitated alumina, fumed alumina, precipitated silica, fumed silica, and mixtures thereof.
- 36. The method of claim 24 wherein the organic acid is succinic acid.
- 37. A method for polishing a substrate including a titanium adhesion layer, a titanium nitride layer and an aluminum alloy containing layer comprising: (a) admixing, hydrogen peroxide, ammonium persulfate, succinic acid, and alumina with deionized water to give a mechanical chemical polishing slurry comprising from about from about 1.0 to about

9.0 weight percent alumina, from about 0.2 to about 10.0 weight percent ammonium persulfate, from about 0.5 to about 10.0 weight percent hydrogen peroxide, and from about 0.5 to about 3.0 succinic acid, wherein the pH of the chemical mechanical polishing slurry ranges from about 2.0 to about 8.0 and wherein the titanium to aluminum alloy polishing selectivity ranges from about 2:1 to about 1:2; (b) applying the chemical mechanical polishing slurry to the substrate; and (c) removing a least a portion of the titanium adhesion layer, at least a portion of the titanium nitride layer and at least a portion of the aluminum alloy layer by bringing a pad into contact with the substrate and moving the pad in relation to the substrate.

38. The method of claim 24 wherein the substrate is selected from the group consisting of integrated circuits, thin films, multiple level semiconductors, and wafers.

INCLM: 438/692.000 INCL

INCLS: 438/693.000; 252/079.200; 051/308.000; 051/309.000; 106/003.000

NCL NCLM: 438/692,000

NCLS: 051/308.000; 051/309.000; 106/003.000; 252/079.200; 438/693.000

IC

ICM: B44C001-22

438/692; 438/693; 252/79.2; 051/308; 051/309; 106/3 EXF

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2838693 AMINO/CNS

87488 TRI/CNS

0 METHLENE/CNS

108697 PHOSPHONIC/CNS

126 CNS/CNS

5867029 ACID/CNS

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L5 3 AMINO/CNS AND TRI/CNS AND METHYLENE/CNS AND PHOSPHONIC/CNS AND ACID/CNS

=> d histr

'HISTR' IS NOT A VALID FORMAT FOR FILE 'REGISTRY'

The following are valid formats:

Substance information can be displayed by requesting individual fields or predefined formats. The predefined substance formats are: (RN = CAS Registry Number)

REG - RN

SAM - Index Name, MF, and structure - no RN FIDE - All substance data, except sequence data

IDE - FIDE, but only 50 names
SQIDE - IDE, plus sequence data

SQIDE3 - Same as SQIDE, but 3-letter amino acid codes are used

SQD - Protein sequence data, includes RN

SQD3 - Same as SQD, but 3-letter amino acid codes are used SQN - Protein sequence name information, includes RN

CALC - Table of calculated properties
EPROP - Table of experimental properties

PROP - EPROP and CALC

Any CA File format may be combined with any substance format to obtain CA references citing the substance. The substance formats must be cited first. The CA File predefined formats are:

ABS -- Abstract

APPS -- Application and Priority Information

BIB -- CA Accession Number, plus Bibliographic Data

CAN -- CA Accession Number

CBIB -- CA Accession Number, plus Bibliographic Data (compressed)

IND -- Index Data

IPC -- International Patent Classification

PATS -- PI, SO

STD -- BIB, IPC, and NCL

IABS --ABS, indented, with text labels

IBIB -- BIB, indented, with text labels

ISTD -- STD format, indented

OBIB ----- AN, plus Bibliographic Data (original) OIBIB ----- OBIB, indented with text labels

SBIB ----- BIB, no citations SIBIB ----- IBIB, no citations

The ALL format gives FIDE BIB ABS IND RE, plus sequence data when it is available.

The MAX format is the same as ALL.

The IALL format is the same as ALL with BIB ABS and IND indented, with text labels.

For additional information, please consult the following help messages:

HELP DFIELDS -- To see a complete list of individual display fields. HELP FORMATS -- To see detailed descriptions of the predefined formats. ENTER DISPLAY FORMAT (IDE):end

=> d hitstr

'HITSTR' IS NOT A VALID FORMAT FOR FILE 'REGISTRY'

The following are valid formats:

Substance information can be displayed by requesting individual fields or predefined formats. The predefined substance formats are: (RN = CAS Registry Number)

REG - RN

SAM - Index Name, MF, and structure - no RN

FIDE - All substance data, except sequence data

IDE - FIDE, but only 50 names SQIDE - IDE, plus sequence data

SQIDE3 - Same as SQIDE, but 3-letter amino acid codes are used

SQD - Protein sequence data, includes RN

SQD3 - Same as SQD, but 3-letter amino acid codes are used

SQN - Protein sequence name information, includes RN

CALC - Table of calculated properties
EPROP - Table of experimental properties

PROP - EPROP and CALC

Any CA File format may be combined with any substance format to obtain CA references citing the substance. The substance formats must be cited first. The CA File predefined formats are:

ABS -- Abstract

APPS -- Application and Priority Information

BIB -- CA Accession Number, plus Bibliographic Data

CAN -- CA Accession Number

CBIB -- CA Accession Number, plus Bibliographic Data (compressed)

IND -- Index Data

IPC -- International Patent Classification

PATS -- PI, SO

STD -- BIB, IPC, and NCL

IABS -- ABS, indented, with text labels

IBIB -- BIB, indented, with text labels

ISTD -- STD format, indented

OBIB ----- AN, plus Bibliographic Data (original)

OIBIB ----- OBIB, indented with text labels

SBIB ----- BIB, no citations SIBIB ----- IBIB, no citations

The ALL format gives FIDE BIB ABS IND RE, plus sequence data when it is available.

The MAX format is the same as ALL.

The IALL format is the same as ALL with BIB ABS and IND indented, with text labels.

For additional information, please consult the following help messages:

HELP DFIELDS -- To see a complete list of individual display fields. HELP FORMATS -- To see detailed descriptions of the predefined formats. ENTER DISPLAY FORMAT (IDE):end

=> file caplus

COST IN U.S. DOLLARS

SINCE FILE TOTAL ENTRY SESSION 64.90 75.09

FULL ESTIMATED COST

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FILE COVERS 1907 - 12 May 2003 VOL 138 ISS 20 FILE LAST UPDATED: 11 May 2003 (20030511/ED)

This file contains CAS Registry Numbers for easy and accurate substance identification.

=> d his

L1

(FILE 'HOME' ENTERED AT 14:19:04 ON 12 MAY 2003)

FILE 'REGISTRY' ENTERED AT 14:19:13 ON 12 MAY 2003 E AMINOTRIMETHYLENEPHOSPHONIC/CN

FILE 'USPATFULL' ENTERED AT 14:21:02 ON 12 MAY 2003 1 S US5783489/PN

FILE 'CAPLUS' ENTERED AT 14:22:04 ON 12 MAY 2003 L2 0 S US5783489/PN

FILE 'REGISTRY' ENTERED AT 14:22:53 ON 12 MAY 2003

L3 0 S AMINO/CNS AND TRI/CNS AND METHLENE/CNS AND PHOSPHONIC/CNS ACI
L4 0 S AMINO/CNS AND TRI/CNS AND METHYLENE/CNS AND PHOSPHONIC/CNS AC
L5 3 S AMINO/CNS AND TRI/CNS AND METHYLENE/CNS AND PHOSPHONIC/CNS AN

FILE 'CAPLUS' ENTERED AT 14:25:10 ON 12 MAY 2003

≈> s 15

L6 44 L5

=> s 11 and 16

0 US5783489/PN

L7 0 L1 AND L6

=> d hitstr

L7 HAS NO ANSWERS

L1 1 SEA FILE≃USPATFULL US5783489/PN

L5 3 SEA FILE=REGISTRY AMINO/CNS AND TRI/CNS AND METHYLENE/CNS AND PHOSPHONIC/CNS AND ACID/CNS

L6 44 SEA FILE=CAPLUS L5

L7 0 SEA FILE=CAPLUS L1 AND L6

=> d 16 hitstr

L6 ANSWER 1 OF 44 CAPLUS COPYRIGHT 2003 ACS

IT 20592-85-2

RL: TEM (Technical or engineered material use); USES (Uses) (bleaching of cellulose pulp with peroxide compds. in presence of a scale inhibitor used as stabilizer)

RN 20592-85-2 CAPLUS

CN Phosphonic acid, [nitrilotris(methylene)]tris-, sodium salt (9CI) (CA INDEX NAME)

$$^{\text{CH}_2-\text{PO}_3\text{H}_2}_{\text{H}_2\text{O}_3\text{P}-\text{CH}_2-\text{N}-\text{CH}_2-\text{PO}_3\text{H}_2}$$

●x Na

# => d his

(FILE 'HOME' ENTERED AT 12:01:33 ON 12 MAY 2003)

| FILE | 'REGI: | STI               | RY' ENTERED AT 12:02:16 ON 12 MAY 2003  |
|------|--------|-------------------|---|
|      |        |                   | PHOSPHONOMETHYLIMINODIACETIC ACID/CN  |
|      | 0      |                   |   |
|      |        | E                 | N-PHOSPHONOMETHYLIMINODIACETIC ACID/CN  |
|      |        | E                 | N-PHOSPHONOMETHYLIMINODIACETIC/CN   |
|      |        | E                 | PHOSPHONOMETHYLIMINODIACETIC/CN   |
|      | 0      | S                 | E3  |
|      |        | Ε                 | N-PHOSPHONOMETHYLIMINODIACETIC ACID/CN  |
|      | 0      |                   |   |
|      |        |                   | ACETODISPHONIC ACID/CN  |
|      |        |                   | METHYLAMINO DIMETHYLENE PHOSPHONIC ACID/CN  |
|      | 1      |                   | PHOSPHONOMETHYLIMINOACETIC ACID/CN  |
|      |        | E                 | N-PHOSPHONOMETHYLIMINODIACETIC ACID/CN  |
|      |        |                   |   |
| FILE | REGIS  |                   | RY' ENTERED AT 12:32:32 ON 12 MAY 2003  |
|      |        |                   | N-PHOSPHONOMETHYLIMINODIACETIC ACID/CN  |
|      | 4      | ສ                 | N-PHOSPHONOMETHYLIMINODIACETIC ACID   |
|      |        | 0 0 1 FILE 'REGIS | E 0 S E E C S S E E C S S E E C S E E C S E E C S E E C S E E C S E E C S E E C S E E C S E E C S E E C S E E E C S E E E E |

=>

Welcome to STN International! Enter x:x

```
LOGINID:ssspta1600LUE
PASSWORD:
TERMINAL (ENTER 1, 2, 3, OR ?):2
* * * * * * * * * *
                     Welcome to STN International
NEWS 1
                 Web Page URLs for STN Seminar Schedule - N. America
NEWS 2 Apr 08
                 "Ask CAS" for self-help around the clock
NEWS 3 Jun 03
                 New e-mail delivery for search results now available
NEWS 4 Aug 08
                 PHARMAMarketLetter(PHARMAML) - new on STN
NEWS 5 Aug 19
                 Aquatic Toxicity Information Retrieval (AQUIRE)
                 now available on STN
NEWS 6 Aug 26
                 Sequence searching in REGISTRY enhanced
NEWS 7
         Sep 03
                 JAPIO has been reloaded and enhanced
NEWS 8
         Sep 16
                 Experimental properties added to the REGISTRY file
NEWS 9
         Sep 16
                CA Section Thesaurus available in CAPLUS and CA
NEWS 10 Oct 01 CASREACT Enriched with Reactions from 1907 to 1985
NEWS 11 Oct 24 BEILSTEIN adds new search fields
NEWS 12 Oct 24 Nutraceuticals International (NUTRACEUT) now available on STN
NEWS 13 Nov 18 DKILIT has been renamed APOLLIT
NEWS 14 Nov 25 More calculated properties added to REGISTRY
NEWS 15 Dec 04 CSA files on STN
NEWS 16 Dec 17 PCTFULL now covers WP/PCT Applications from 1978 to date
NEWS 17 Dec 17 TOXCENTER enhanced with additional content
NEWS 18 Dec 17 Adis Clinical Trials Insight now available on STN
NEWS 19 Jan 29
                 Simultaneous left and right truncation added to COMPENDEX,
                 ENERGY, INSPEC
NEWS 20 Feb 13 CANCERLIT is no longer being updated
NEWS 21 Feb 24 METADEX enhancements
NEWS 22 Feb 24 PCTGEN now available on STN
NEWS 23 Feb 24 TEMA now available on STN
NEWS 24 Feb 26 NTIS now allows simultaneous left and right truncation
NEWS 25 Feb 26 PCTFULL now contains images
NEWS 26 Mar 04 SDI PACKAGE for monthly delivery of multifile SDI results
NEWS 27 Mar 19 APOLLIT offering free connect time in April 2003
NEWS 28 Mar 20 EVENTLINE will be removed from STN
NEWS 29 Mar 24 PATDPAFULL now available on STN
NEWS 30 Mar 24 Additional information for trade-named substances without
                 structures available in REGISTRY
NEWS 31
        Apr 11 Display formats in DGENE enhanced
NEWS 32
         Apr 14
                 MEDLINE Reload
NEWS 33
         Apr 17
                 Polymer searching in REGISTRY enhanced
NEWS 34
         Apr 21 Indexing from 1947 to 1956 being added to records in CA/CAPLUS
NEWS 35 Apr 21 New current-awareness alert (SDI) frequency in
                 WPIDS/WPINDEX/WPIX
NEWS 36 Apr 28
                 RDISCLOSURE now available on STN
NEWS 37 May 05
                 Pharmacokinetic information and systematic chemical names
                 added to PHAR
NEWS EXPRESS April 4 CURRENT WINDOWS VERSION IS V6.01a, CURRENT
              MACINTOSH VERSION IS V6.0b(ENG) AND V6.0Jb(JP),
              AND CURRENT DISCOVER FILE IS DATED 01 APRIL 2003
```

NEWS HOURS STN Operating Hours Plus Help Desk Availability
NEWS INTER General Internet Information
NEWS LOGIN Welcome Banner and News Items
NEWS PHONE Direct Dial and Telecommunication Network Access to STN
NEWS WWW CAS World Wide Web Site (general information)

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FILE 'HOME' ENTERED AT 12:01:33 ON 12 MAY 2003

#### => registry

THIS COMMAND NOT AVAILABLE IN THE CURRENT FILE Some commands only work in certain files. For example, the EXPAND command can only be used to look at the index in a file which has an index. Enter "HELP COMMANDS" at an arrow prompt (=>) for a list of commands which can be used in this file.

=> file registry
COST IN U.S. DOLLARS

SINCE FILE TOTAL ENTRY SESSION 0.21 0.21

FULL ESTIMATED COST

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Property values tagged with IC are from the ZIC/VINITI data file provided by InfoChem.  $\,$ 

STRUCTURE FILE UPDATES: 11 MAY 2003 HIGHEST RN 514167-89-6 DICTIONARY FILE UPDATES: 11 MAY 2003 HIGHEST RN 514167-89-6

TSCA INFORMATION NOW CURRENT THROUGH JANUARY 6, 2003

Please note that search-term pricing does apply when conducting SmartSELECT searches.

Crossover limits have been increased. See HELP CROSSOVER for details.

Experimental and calculated property data are now available. See HELP PROPERTIES for more information. See STNote 27, Searching Properties in the CAS Registry File, for complete details: http://www.cas.org/ONLINE/STN/STNOTES/stnotes27.pdf

=> e phosphonomethyliminodiacetic acid/cn

| Tri Tr | T  | FROSERONOMETHIEGHICINE/CN     |         |
|--------|----|-------------------------------|---------|
| E2     | 1  | PHOSPHONOMETHYLIMINOACETIC AC | ID/CN   |
| E3     | 0> | PHOSPHONOMETHYLIMINODIACETIC  | ACID/CN |

E4 1 PHOSPHONOMETHYLIMINODIACETIC ACID/CN

| E5         | 1         | PHOSPHONOMUTASE 2 (ESCHERICHIA COLI 0157:H7 STRAIN EDL933 GE   |
|------------|-----------|--|
|            | _         | NE PRPB)/CN  |
| Еб         | 1         | PHOSPHONOMUTASE 2 (ESCHERICHIA COLI STRAIN 0157:H7 GENE ECSO   |
| E7         | 1         | 385)/CN PHOSPHONOMUTASE, CARBOXYPHOSPHONOENOLPYRUVATE/CN   |
| E8         | 1         | PHOSPHONOMUTASE, CARBOXYPHOSPHONOENOLPYRUVATE (PHYSCOMITRELL   |
| 150        | 1         | A PATENS CLONE 88 MM13 G11REV FRAGMENT)/CN   |
| E9         | 1         | PHOSPHONOMUTASE, CARBOXYPHOSPHONOENOLPYRUVATE (STREPTOMYCES  |
|            | -         | HYGROSCOPICUS CLONE PBS-BAM3 SUBUNIT REDUCED)/CN   |
| E10        | 1         | PHOSPHONOMUTASE, CARBOXYPHOSPHONOENOLPYRUVATE (STREPTOMYCES  |
|            |           | HYGROSCOPICUS CLONE PMSB113 REDUCED)/CN  |
| E11        | 1         | PHOSPHONOMUTASE, CARBOXYPHOSPHONOENOLPYRUVATE (SULFOLOBUS SO   |
|            |           | LFATARICUS GENE PRPB)/CN   |
| E12        | 1         | PHOSPHONOMYCIN/CN  |
|            |           |  |
| => s e3    | 0 HD1     | TO CHICAGO MANUAL TATAO DE LA CONTRA LA CENTRA |
| L1         | 0 5 H     | HOSPHONOMETHYLIMINODIACETIC ACID"/CN   |
| => A N-nh  | osnhonome | ethyliminodiacetic acid/cn   |
| E1         | 1         | N-PHOSPHONOMETHYLGLYCINE SODIUM SALT/CN  |
| E2         | î         | N-PHOSPHONOMETHYLGLYCINE TRISODIUM SALT/CN   |
| E3         | _         | N-PHOSPHONOMETHYLIMINODIACETIC ACID/CN   |
| E4         | 1         | N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE DISODIUM SALT/CN   |
| E5         | 1         | N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE MONOSODIUM SALT/   |
| 23         | 1         | CN   |
| E6         | 1         | N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE TETRASODIUM SALT   |
| 20         | -         | /CN  |
| E7         | 1         | N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE TRISODIUM SALT/C   |
|            |           | N  |
| E8         | 1         | N-PHOSPHOPYRIDOXYLGAMMAAMINOBUTYRIC ACID/CN  |
| E9         | 1         | N-PHOSPHOPYRIDOXYL-GLYCINE/CN  |
| E10        | 1         | N-PHOSPHOPYRIDOXYL-L-ALANINE/CN  |
| E11        | 1         | N-PHOSPHORANYLIDENESILYLAMINE/CN   |
| E12        | 1         | N-PHOSPHORIBOSYLANTHRANILATE ISOMERASE-INDOLEGLYCEROL PHOSPH   |
| 512        | 7         | ATE SYNTHETASE (BUCHNERA APHIDICOLA CLONE PBS2T-1 GENE TRPC)   |
|            |           | F))/CN   |
|            |           |  |
| => e N-ph  | osphonome | ethyliminodiacetic/cn  |
| E1         | 1         | N-PHOSPHONOMETHYLGLYCINE SODIUM SALT/CN  |
| E2         | 1         | N-PHOSPHONOMETHYLGLYCINE TRISODIUM SALT/CN   |
| E3         | 0 ~->     | N-PHOSPHONOMETHYLIMINODIACETIC/CN  |
| E4         | 1         | N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE DISODIUM SALT/CN   |
| E5         | 1         | N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE MONOSODIUM SALT/   |
|            |           | CN   |
| E6         | 1         | N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE TETRASODIUM SALT   |
|            | _         | /CN  |
| E7         | 1         | N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE TRISODIUM SALT/C   |
| <b>T</b> 0 | 1         | N  |
| E8         | 1         | N-PHOSPHOPYRIDOXYLGAMMAAMINOBUTYRIC ACID/CN  |
| E9         | 1         | N-PHOSPHOPYRIDOXYL-GLYCINE/CN  |
| E10        | 1         | N-PHOSPHOPYRIDOXYL-L-ALANINE/CN  |
| E11        | 1         | N-PHOSPHORANYLIDENESILYLAMINE/CN   |
| E12        | 1         | N-PHOSPHORIBOSYLANTHRANILATE ISOMERASE-INDOLEGLYCEROL PHOSPH   |
|            |           | ATE SYNTHETASE (BUCHNERA APHIDICOLA CLONE PBS2T-1 GENE TRPC)   |
|            |           | F))/CN   |
| ->         |           | and denotes a literature from  |
|            |           | yliminodiacetic/cn   |
| E1         | 1         | PHOSPHONOMETHYLGLYCINE/CN  |
| E2         | 1         | PHOSPHONOMETHYLIMINOACETIC ACID/CN   |
| E3         |           | PHOSPHONOMETHYLIMINODIACETIC/CN  |
| E4         | 1         | PHOSPHONOMETHYLIMINODIACETIC ACID/CN   |
| E5         | 1         | PHOSPHONOMUTASE 2 (ESCHERICHIA COLI 0157:H7 STRAIN EDL933 GE   |
|            |           |  |

```
NE PRPB)/CN
                   PHOSPHONOMUTASE 2 (ESCHERICHIA COLI STRAIN 0157:H7 GENE ECSO
E6
             1
E7
                   PHOSPHONOMUTASE, CARBOXYPHOSPHONOENOLPYRUVATE/CN
E.B
             1
                   PHOSPHONOMUTASE, CARBOXYPHOSPHONOENOLPYRUVATE (PHYSCOMITRELL
                   A PATENS CLONE 88 MM13 G11REV FRAGMENT)/CN
E9
                   PHOSPHONOMUTASE, CARBOXYPHOSPHONOENOLPYRUVATE (STREPTOMYCES
             1
                   HYGROSCOPICUS CLONE PBS-BAM3 SUBUNIT REDUCED)/CN
                   PHOSPHONOMUTASE, CARBOXYPHOSPHONOENOLPYRUVATE (STREPTOMYCES
E10
             1
                   HYGROSCOPICUS CLONE PMSB113 REDUCED)/CN
                   PHOSPHONOMUTASE, CARBOXYPHOSPHONOENOLPYRUVATE (SULFOLOBUS SO
E11
             1
                   LFATARICUS GENE PRPB)/CN
                   PHOSPHONOMYCIN/CN
E12
             1
=> s e3
             O PHOSPHONOMETHYLIMINODIACETIC/CN
=> d 12
L2 HAS NO ANSWERS
              O SEA FILE=REGISTRY PHOSPHONOMETHYLIMINODIACETIC/CN
=> e N-phosphonomethyliminodiacetic acid/cn
                   N-PHOSPHONOMETHYLGLYCINE SODIUM SALT/CN
             7
                   N-PHOSPHONOMETHYLGLYCINE TRISODIUM SALT/CN
E3
             0 --> N-PHOSPHONOMETHYLIMINODIACETIC ACID/CN
E4
                   N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE DISODIUM SALT/CN
E5
             1
                   N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE MONOSODIUM SALT/
                   CN
E6
                   N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE TETRASODIUM SALT
E7
                   N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE TRISODIUM SALT/C
             1
E8
                   N-PHOSPHOPYRIDOXYL-.GAMMA.-AMINOBUTYRIC ACID/CN
             7
                   N-PHOSPHOPYRIDOXYL-GLYCINE/CN
E.9
             1
E10
                   N-PHOSPHOPYRIDOXYL-L-ALANINE/CN
E11
                   N-PHOSPHORANYLIDENESILYLAMINE/CN
             1
                   N-PHOSPHORIBOSYLANTHRANILATE ISOMERASE-INDOLEGLYCEROL PHOSPH
E12
             1
                   ATE SYNTHETASE (BUCHNERA APHIDICOLA CLONE PBS2T-1 GENE TRPC(
                   F))/CN
≈> s e3
             0 "N-PHOSPHONOMETHYLIMINODIACETIC ACID"/CN
L3
=> e acetodisphonic acid/cn
                   ACETOCYANOHYDRIN/CN
E.1
             1
F.2
             1
                   ACETODIPHOSPHONIC ACID/CN
E3
             0 --> ACETODISPHONIC ACID/CN
                   ACETOEVERNONE/CN
F.4
             1
E5
             1
                   ACETOFENATE/CN
E6
             1
                   ACETOFERROCENE/CN
E7
                   ACETOFLOCINIPIPERIDOL/CN
             1
E8
            1
                   ACETOFORMIC ANHYDRIDE/CN
E9
            1
                   ACETOFURAN/CN
E10
            1
                   ACETOGENIN G/CN
E11
                   ACETOGLYCERIDE/CN
             1
E12
             1
                   ACETOGLYCERIDE LC/CN
=> e methylamino dimethylene phosphonic acid/cn
E1
             1
                   METHYLAMINO/CN
E2
             1
                   METHYLAMINO ABAMECTIN BENZOATE/CN
```

```
E3
             0 --> METHYLAMINO DIMETHYLENE PHOSPHONIC ACID/CN
E4
                   METHYLAMINO-N, N-BIS (2-METHYLENE-4, 6-DIMETHYLPHENOL) / CN
             1
E5
                   METHYLAMINO-N, N-BIS (2-METHYLENE-4, 6-DIMETHYLPHENOL) N-OXIDE/C
             1
Е6
             1
                   METHYLAMINO-O-ETHYL-O-(3,4,5-TRICHLOROPHENYL)THIONOPHOSPHONA
                   TE/CN
                   METHYLAMINOACETALDEHYDE DIETHYL ACETAL/CN
E7
             1
E8
                   METHYLAMINOACETAMIDE/CN
             1
Ε9
             1
                   METHYLAMINOACETONE ETHYLENE KETAL/CN
E10
             1
                   METHYLAMINOACETONITRILE BISULFATE/CN
E11
             1
                   METHYLAMINOANTIPYRINE/CN
E12
             1
                   METHYLAMINOANTIPYRINE N-DEMETHYLASE/CN
=> s PHOSPHONOMETHYLIMINOACETIC ACID/CN
             1 PHOSPHONOMETHYLIMINOACETIC ACID/CN
=> d 14
     ANSWER 1 OF 1 REGISTRY COPYRIGHT 2003 ACS
L4
RN
     1071-83-6 REGISTRY
     Glycine, N-(phosphonomethyl) - (7CI, 8CI, 9CI) (CA INDEX NAME)
CN
OTHER NAMES:
CN
     (Carboxymethylamino) methylphosphonic acid
CN
CN
     Carboxymethylaminomethanephosphinic acid
CN
     Folusen
CN
     Forsat
CN
     Glialka
CN
     Glialka 36
CN
     Glyphodin A
CN
     Glyphomax
CN
     Glyphosate
CN
     Glyphosate CT
CN
     Herbatop
CN
     Hockey
CN
     Kickdown
CN
    Lancer
    MON 2139
CN
    MON 6000
CN
CN
     N-Phosphomethylglycine
CN
     N-Phosphonomethylglycine
CN
     Phorsat
CN
     Phosphonomethylglycine
CN
     Phosphonomethyliminoacetic acid
     Rebel Garden
CN
FS
     3D CONCORD
     37337-60-3, 75241-08-6, 42618-09-7
DR
MF
     C3 H8 N O5 P
CI
     COM
T.C.
                 AGRICOLA, ANABSTR, AQUIRE, BEILSTEIN*, BIOBUSINESS, BIOSIS,
     STN Files:
       BIOTECHNO, CA, CABA, CANCERLIT, CAOLD, CAPLUS, CASREACT, CBNB, CEN,
       CHEMCATS, CHEMINFORMRX, CHEMLIST, CIN, CSCHEM, CSNB, DDFU, DRUGU,
       EMBASE, GMELIN*, HSDB*, IFICDB, IFIPAT, IFIUDB, IPA, MEDLINE, MRCK*,
       MSDS-OHS, NIOSHTIC, PIRA, PROMT, RTECS*, SPECINFO, TOXCENTER, ULIDAT,
       USPAT2, USPATFULL
         (*File contains numerically searchable property data)
     Other Sources:
                      DSL**, EINECS**
         (**Enter CHEMLIST File for up-to-date regulatory information)
```

## \*\*PROPERTY DATA AVAILABLE IN THE 'PROP' FORMAT\*\*

4396 REFERENCES IN FILE CA (1957 TO DATE)

257 REFERENCES TO NON-SPECIFIC DERIVATIVES IN FILE CA

4403 REFERENCES IN FILE CAPLUS (1957 TO DATE)

2 REFERENCES IN FILE CAOLD (PRIOR TO 1967)

| ≈> e | N-phosphonom | ethyliminodiacetic acid/cn   |
|------|--------------|--|
| E1   | 1            | N-PHOSPHONOMETHYLGLYCINE SODIUM SALT/CN  |
| E2   | 1            | N-PHOSPHONOMETHYLGLYCINE TRISODIUM SALT/CN   |
| E3   | 0 ~->        | N-PHOSPHONOMETHYLIMINODIACETIC ACID/CN   |
| E4   | 1            | N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE DISODIUM SALT/CN   |
| E5   | 1            | N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE MONOSODIUM SALT/CN   |
| E6   | 1            | N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE TETRASODIUM SALT /CN $$  |
| E7   | 1            | N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE TRISODIUM SALT/C N   |
| E8   | 1            | N-PHOSPHOPYRIDOXYLGAMMAAMINOBUTYRIC ACID/CN  |
| E9   | 1            | N-PHOSPHOPYRIDOXYL-GLYCINE/CN  |
| E10  | 1            | N-PHOSPHOPYRIDOXYL-L-ALANINE/CN  |
| E11  | 1            | N-PHOSPHORANYLIDENESILYLAMINE/CN   |
| E12  | 1            | N-PHOSPHORIBOSYLANTHRANILATE ISOMERASE-INDOLEGLYCEROL PHOSPH<br>ATE SYNTHETASE (BUCHNERA APHIDICOLA CLONE PBS2T-1 GENE TRPC) |

=> file registry
COST IN U.S. DOLLARS

SINCE FILE TOTAL ENTRY SESSION 38.56 38.77

FULL ESTIMATED COST

FILE 'REGISTRY' ENTERED AT 12:32:32 ON 12 MAY 2003 USE IS SUBJECT TO THE TERMS OF YOUR STN CUSTOMER AGREEMENT. PLEASE SEE "HELP USAGETERMS" FOR DETAILS.

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F))/CN

Property values tagged with IC are from the ZIC/VINITI data file provided by InfoChem.

STRUCTURE FILE UPDATES: 11 MAY 2003 HIGHEST RN 514167-89-6 DICTIONARY FILE UPDATES: 11 MAY 2003 HIGHEST RN 514167-89-6

TSCA INFORMATION NOW CURRENT THROUGH JANUARY 6, 2003

Please note that search-term pricing does apply when conducting SmartSELECT searches.

Crossover limits have been increased. See HELP CROSSOVER for details.

Experimental and calculated property data are now available. See HELP PROPERTIES for more information. See STNote 27, Searching Properties in the CAS Registry File, for complete details: http://www.cas.org/ONLINE/STN/STNOTES/stnotes27.pdf

=> e N-phosphonomethyliminodiacetic acid/cn

| E1 | N-PHOSPHONOMETHYLGLYCINE SODIUM SALT/CN                    |    |
|----|--|----|
| E2 | N-PHOSPHONOMETHYLGLYCINE TRISODIUM SALT/CN                 |    |
| E3 | > N-PHOSPHONOMETHYLIMINODIACETIC ACID/CN                   |    |
| E4 | N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE DISODIUM SALT/ | CN |
| E5 | N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE MONOSODIUM SAL | Γ/ |

E6 1 N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE TETRASODIUM SALT /CN E7 1 N-PHOSPHONOMETHYLIMINODIACETIC ACID N-OXIDE TRISODIUM SALT/C E8 N-PHOSPHOPYRIDOXYL-.GAMMA.-AMINOBUTYRIC ACID/CN 1 E9 1 N-PHOSPHOPYRIDOXYL-GLYCINE/CN E10 1 N-PHOSPHOPYRIDOXYL-L-ALANINE/CN E11 1 N-PHOSPHORANYLIDENESILYLAMINE/CN E12 1 N-PHOSPHORIBOSYLANTHRANILATE ISOMERASE-INDOLEGLYCEROL PHOSPH ATE SYNTHETASE (BUCHNERA APHIDICOLA CLONE PBS2T-1 GENE TRPC( F))/CN => s N-phosphonomethyliminodiacetic acid 4653138 N 5 PHOSPHONOMETHYLIMINODIACETIC 5887866 ACID L54 N-PHOSPHONOMETHYLIMINODIACETIC ACID (N(W) PHOSPHONOMETHYLIMINODIACETIC(W) ACID) => d 15, all ANSWER 1 OF 4 REGISTRY COPYRIGHT 2003 ACS T<sub>1</sub>5 RN90041-38-6 REGISTRY Glycine, N-(carboxymethyl)-N-(phosphonomethyl)-, N-oxide, sodium salt (9CI) (CA INDEX NAME) OTHER NAMES: CN N-Phosphonomethyliminodiacetic acid N-oxide monosodium salt  $C5\ H10\ N\ O8\ P$  . x Na MF LC STN Files: CA, CAPLUS, USPATFULL CRN (53792-63-5)

$$\begin{array}{c} {\rm O} \\ || \\ {\rm HO_2C-CH_2-N-CH_2-CO_2H} \\ | \\ {\rm CH_2-PO_3H_2} \end{array}$$

# ●x Na

1 REFERENCES IN FILE CA (1957 TO DATE)
1 REFERENCES IN FILE CAPLUS (1957 TO DATE)

# REFERENCE 1

ΑN 100:187352 CA TIN-Organophosphonomethylglycine N-oxides and their use to increase the sucrose content of sugarcane IN Franz, John E. PA Monsanto Co. , USA SO U.S., 4 pp. Cont.-in-part of U.S. Ser. No. 6133,707, abandoned. CODEN: USXXAM DTPatent English LΑ IC A01N057-00 NCL 071086000 5-3 (Agrochemical Bioregulators) CC. FAN.CNT 4

```
PATENT NO.
                     KIND DATE
                                           APPLICATION NO. DATE
     -----
    US 4435204 A 19840306 US 1980-133379 19800324
AT 792975 A 19780215 AT 1975-7929 19731210
AT 345864 B 19780815
AT 343135 B 19780510 AT 1975-7931 19751017
DK 7600538 A 19760210 DK 1976-538 19760210
DK 142162 B 19800915
DK 142162 C 19810216
PT
     DK 142162
                      C 19810216
     DK 7600537
DK 141951
                     A 19760210
B 19800728
                                            DK 1976-537 19760210
     DK 141951
                       С
                            19801215
PRAI US 1972-313706 19721211
     US 1975-613707 19750915
     AT 1973-10302 19731210
     DK 1973-6678
                       19731210
AB
     Phosphonomethylglycine N-oxides, prepd. as described in US 4,062,669,
     increased sucrose [57-50-1] content of sugarcane when applied 2-10 wk
     prior to harvest, at .apprx.0.112-5.6 kg/ha. Examples are:
     N-phosphonomethyliminodiacetic acid N-oxide [53792-63-5],
     N-methyl-N-phosphonomethylglycine N-oxide [53792-84-0], and Et
     N, N-bis (phosphonomethyl) glycine N-oxide [69595-84-2]. These compds.
     increased juice purity percentage and sucrose content (Pol percent cane).
ST
     phosphonomethylglycine oxide sugarcane sucrose
IT
     Sugarcane
        (sucrose of, organophosphonomethylglycine oxides increase of)
     57-50-1, biological studies
IT
     RL: BIOL (Biological study)
        (of sugarcane, organophosphonomethylglycine oxides increase of)
     24569-83-3 53792-63-5 53792-64-6 53792-65-7 53792-66-8
IT
     53792-67-9 53792-68-0 53792-69-1 53792-70-4
                                                           53792-71-5
     53792-73-7 53792-75-9 53792-76-0 53792-79-3 53792-80-6
     53792-82-8 53792-84-0 53792-86-2 69595-83-1 69595-84-2
     69595-86-4 69595-87-5 90041-38-6 90041-39-7 90041-40-0
     90041-41-1
     RL: BIOL (Biological study)
        (sucrose content increase by, in sugarcane)
=> d 2-4 kwic
    ANSWER 2 OF 4 REGISTRY COPYRIGHT 2003 ACS
OTHER NAMES:
    N-Phosphonomethyliminodiacetic acid N-oxide tetrasodium salt
     ANSWER 3 OF 4 REGISTRY COPYRIGHT 2003 ACS
L5
OTHER NAMES:
    N-Phosphonomethyliminodiacetic acid N-oxide trisodium salt
     ANSWER 4 OF 4 REGISTRY COPYRIGHT 2003 ACS
L5
OTHER NAMES:
     N-Phosphonomethyliminodiacetic acid N-oxide disodium salt
=> d his
     (FILE 'HOME' ENTERED AT 12:01:33 ON 12 MAY 2003)
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L1 0 S E3
E N-PHOSPHONOMETHYLIMINODIACETIC ACID/CN

FILE 'REGISTRY' ENTERED AT 12:02:16 ON 12 MAY 2003

E PHOSPHONOMETHYLIMINODIACETIC ACID/CN

E N-PHOSPHONOMETHYLIMINODIACETIC/CN

E PHOSPHONOMETHYLIMINODIACETIC/CN

L2 0 S E3

E N-PHOSPHONOMETHYLIMINODIACETIC ACID/CN

L3 0 S E3

E ACETODISPHONIC ACID/CN

E METHYLAMINO DIMETHYLENE PHOSPHONIC ACID/CN

L4 1 S PHOSPHONOMETHYLIMINOACETIC ACID/CN

E N-PHOSPHONOMETHYLIMINODIACETIC ACID/CN

FILE 'REGISTRY' ENTERED AT 12:32:32 ON 12 MAY 2003

E N-PHOSPHONOMETHYLIMINODIACETIC ACID/CN

L5 4 S N-PHOSPHONOMETHYLIMINODIACETIC ACID

=> d 15, 1-4, all

L5 ANSWER 1 OF 4 REGISTRY COPYRIGHT 2003 ACS

RN 90041-38-6 REGISTRY

CN Glycine, N-(carboxymethyl)-N-(phosphonomethyl)-, N-oxide, sodium salt (9CI) (CA INDEX NAME)

OTHER NAMES:

CN N-Phosphonomethyliminodiacetic acid N-oxide monosodium salt

MF C5 H10 N O8 P . x Na

LC STN Files: CA, CAPLUS, USPATFULL

CRN (53792-63-5)

## ●x Na

- 1 REFERENCES IN FILE CA (1957 TO DATE)
- 1 REFERENCES IN FILE CAPLUS (1957 TO DATE)

## REFERENCE 1

AN 100:187352 CA

 ${
m TI}$  N-Organophosphonomethylglycine N-oxides and their use to increase the sucrose content of sugarcane

IN Franz, John E.

PA Monsanto Co., USA

SO U.S., 4 pp. Cont.-in-part of U.S. Ser. No. 6133,707, abandoned. CODEN: USXXAM

DT Patent

LA English

IC A01N057-00

NCL 071086000

CC 5-3 (Agrochemical Bioregulators)

FAN.CNT 4

| DAMENIM NO. UTIN DAME | APPLICATION NO. DATE                    |
|-----------------------|---|
| PATENT NO. KIND DATE  | 711121111111111111111111111111111111111 |
|                       |   |
| PI US 4435204 A 19840 | 306 US 1980-133379 19800324             |
| AT 792975 A 19780     | 215 AT 1975-7929 19731210               |
| AT 345864 B 19780     | 315                                     |
| AT 343135 B 19780     | 510 AT 1975-7931 19751017               |

```
DK 7600538
                      A 19760210
                                          DK 1976-538
                                                          19760210
     DK 142162
                     В 19800915
     DK 142162
                     C 19810216
     DK 7600537
                     A 19760210
                                          DK 1976-537
                                                          19760210
     DK 141951
                     B 19800728
     DK 141951
                     C
                           19801215
PRAI US 1972-313706 19721211
     US 1975-613707 19750915
     AT 1973-10302
                     19731210
     DK 1973-6678
                     19731210
     Phosphonomethylglycine N-oxides, prepd. as described in US 4,062,669,
AΒ
     increased sucrose [57-50-1] content of sugarcane when applied 2-10 wk
     prior to harvest, at .apprx.0.112-5.6 kg/ha. Examples are:
    N-phosphonomethyliminodiacetic acid N-oxide [53792-63-5],
    N-methyl-N-phosphonomethylglycine N-oxide [53792-84-0], and Et
    N, N-bis (phosphonomethyl) glycine N-oxide [69595-84-2]. These compds.
     increased juice purity percentage and sucrose content (Pol percent cane).
ST
    phosphonomethylglycine oxide sugarcane sucrose
IT
     Sugarcane
       (sucrose of, organophosphonomethylglycine oxides increase of)
     57-50-1, biological studies
IT
     RL: BIOL (Biological study)
        (of sugarcane, organophosphonomethylglycine oxides increase of)
IT
     24569-83-3 53792-63-5 53792-64-6 53792-65-7
                                                       53792-66-8
     53792-67-9
                 53792-68-0
                              53792-69-1
                                          53792-70-4
                                                       53792-71-5
                              53792-76-0
     53792-73-7
                 53792-75-9
                                          53792-79-3
                                                       53792-80-6
               53792-84-0
     53792-82-8
                              53792-86-2
                                          69595-83-1
                                                       69595-84-2
                 69595-87-5 90041-38-6
                                         90041-39-7
     69595-86-4
                                                       90041-40-0
     90041-41-1
    RL: BIOL (Biological study)
       (sucrose content increase by, in sugarcane)
L5
    ANSWER 2 OF 4 REGISTRY COPYRIGHT 2003 ACS
    53792-86-2 REGISTRY
RN
    Glycine, N-(carboxymethyl)-N-(phosphonomethyl)-, N-oxide, tetrasodium salt
CN
     (9CI) (CA INDEX NAME)
OTHER NAMES:
    N-Phosphonomethyliminodiacetic acid N-oxide tetrasodium salt
    C5 H10 N O8 P . 4 Na
LC
    STN Files:
                CA, CAPLUS, IFICDB, IFIPAT, IFIUDB, TOXCENTER, USPATFULL
CRN (53792-63-5)
          0
```

$$\begin{array}{c} {\rm O} \\ || \\ {\rm Ho_2C-CH_2-N-CH_2-Co_2H} \\ | \\ {\rm CH_2-Po_3H_2} \end{array}$$

# ●4 Na

- 4 REFERENCES IN FILE CA (1957 TO DATE)
- 4 REFERENCES IN FILE CAPLUS (1957 TO DATE)

## REFERENCE 1

- AN 100:187352 CA
- TI N-Organophosphonomethylglycine N-oxides and their use to increase the sucrose content of sugarcane

```
Franz, John E.
IN
PA
      Monsanto Co. , USA
      U.S., 4 pp. Cont.-in-part of U.S. Ser. No. 6133,707, abandoned.
      CODEN: USXXAM
DT
      Patent
     English
LA
      A01N057-00
IC
NCL 071086000
CC
      5-3 (Agrochemical Bioregulators)
FAN.CNT 4
     US 4435204 A 19840306 US 1980-133379 19800324
AT 792975 A 19780215 AT 1975-7929 19731210
AT 345864 B 19780815
AT 343135 B 19780510 AT 1975-7931 19751017
DK 7600538 A 19760210 DK 1976-538 19760210
DK 142162 B 19800915
DK 142162 C 19810216
DK 7600537 A 19760210 DK 1976-537 19760210
DK 141951 B 19800728
DK 141951 C 19801215
US 1972-313706 19721211
                                                  APPLICATION NO. DATE
      PATENT NO.
                         KIND DATE
ΡI
PRAI US 1972-313706 19721211
      US 1975-613707 19750915
      AT 1973-10302 19731210
      DK 1973-6678
                          19731210
AB
      Phosphonomethylglycine N-oxides, prepd. as described in US 4,062,669,
      increased sucrose [57-50-1] content of sugarcane when applied 2-10 wk
      prior to harvest, at .apprx.0.112-5.6 kg/ha. Examples are:
      N-phosphonomethyliminodiacetic acid N-oxide [53792-63-5],
      N-methyl-N-phosphonomethylglycine N-oxide [53792-84-0], and Et
      N, N-bis (phosphonomethyl) glycine N-oxide [69595-84-2]. These compds.
      increased juice purity percentage and sucrose content (Pol percent cane).
ST
      phosphonomethylglycine oxide sugarcane sucrose
IT
      Sugarcane
         (sucrose of, organophosphonomethylglycine oxides increase of)
ΙT
      57-50-1, biological studies
      RL: BIOL (Biological study)
         (of sugarcane, organophosphonomethylglycine oxides increase of)
      24569-83-3 53792-63-5 53792-64-6 53792-65-7 53792-66-8
IT
      53792-67-9 \qquad 53792-68-0 \qquad 53792-69-1 \qquad 53792-70-4 \qquad 53792-71-5
      53792 - 73 - 7 \qquad 53792 - 75 - 9 \qquad 53792 - 76 - 0 \qquad 53792 - 79 - 3 \qquad 53792 - 80 - 6
      53792 - 82 - 8 \qquad 53792 - 84 - 0 \qquad 53792 - 86 - 2 \qquad 69595 - 83 - 1 \qquad 69595 - 84 - 2
      69595 - 86 - 4 \qquad 69595 - 87 - 5 \qquad 90041 - 38 - 6 \qquad 90041 - 39 - 7 \qquad 90041 - 40 - 0
      90041-41-1
      RL: BIOL (Biological study)
         (sucrose content increase by, in sugarcane)
REFERENCE 2
AN
      90:138024 CA
      \hbox{N-Organo-N-phosphonomethylglycine $N-$oxides and phytotoxicant compositions}
      containing them
IN
     Franz, John E.
PΑ
     Monsanto Co., USA
     U.S., 11 pp. Cont.-in-part of U.S. 4,062,669.
     CODEN: USXXAM
\mathbf{DT}
     Patent
LA
    English
IC
     A01N009-36
NCL 071086000
CC 29-7 (Organometallic and Organometalloidal Compounds)
```

Section cross-reference(s): 5 FAN.CNT 4 KIND DATE PATENT NO. APPLICATION NO. DATE \_\_\_\_\_\_ \_\_\_\_\_ US 4130412 A 19781219
AT 792975 A 19780215
AT 345864 B 19780815
US 4062669 A 19771213
AT 343135 B 19780510
DK 7600538 A 19760210
DK 142162 B 19800915
DK 142162 C 19810216
DK 7600537 A 19760210 US 1977-836187 19770926 PΙ AT 1975-7929 19731210 US 1975-613708 19750915 AT 1975-7931 19751017 DK 1976-538 19760210 DK 7600537 DK 141951 A 19760210 B 19800728 DK 1976-537 19760210 19801215 DK 141951 С PRAI US 1972-313706 19721211 US 1975-613708 19750909 AT 1973-10302 19731210 DK 1973-6678 19731210 The title compds. RO2CCH2N(O)R3CH2P(O)(OR1)(OR2) [I, R1, R2 = H, metal AB cation, ammonium; R, R1 = alkyl; R3 = CnH2nCO2R, n = 1-10] were prepd. by oxidn. of RO2CCH2NR3CH2P(O)(OR1)(OR2) with per acids. Thus, 0.06 mol [HO2CCH2]2NCH2P(O)(OH)2, 100 mL. HOAc, and 0.6 g H2SO4 was treated with 0.21 mol H2O2 at 75-80.degree. to give 9.2 g [HO2CCH2]2N(O)CH2P(O)(OH)2 (II). At 4 lb/acre II gave 100% kill of Canada Thistle, Lambsquarters, Nutsedge, and Quackgrass. STherbicide phosphonomethylglycine oxide; phytotoxicant phosphonomethylglycine oxide; oxidn phosphonomethylglycine; glycine phosphonomethyl oxide ITHerbicides (phosphonomethylglycine oxides) 53792-79-3 ΙT 53792-64-6 53792-66-8 53792-78-2 53792-80-6 53792-83-9 53792-81-7 53792-82-8 RL: BAC (Biological activity or effector, except adverse); BSU (Biological study, unclassified); BIOL (Biological study) (herbicidal activity of) ΙT 2439-99-8 5994-61-6 24569-83-3 53792-88-4 53792-89-5 69595-88-6 RL: RCT (Reactant); RACT (Reactant or reagent) (oxidn. of) 53792-63-5P 53792-67-9P 53792-68-0P 53792-69-1P 53792-70-4P IT 53792-71-5P 53792-72-6P 53792-74-8P 53792-75-9P 53792-76-0P 53792-84-0P 53792-86-2P 69595-82-0P 69595-83-1P 69595-84-2P 69595-86-4P 69595-87-5P 69595-85-3P RL: AGR (Agricultural use); BAC (Biological activity or effector, except adverse); BSU (Biological study, unclassified); SPN (Synthetic preparation); BIOL (Biological study); PREP (Preparation); USES (Uses) (prepn. and herbicidal activity of) 53792-73-7P IT 53792~65-7P RL: SPN (Synthetic preparation); PREP (Preparation) (prepn. of) REFERENCE 3

- 90:138021 CA AN
- ΤI N-Organo-N-phosphonomethylglycine-N-oxides and phytotoxicant compositions containing them
- Franz, John E. IN
- Monsanto Co., USA
- U.S., 11 pp. Cont.-in-part of U.S. 4,062,669. CODEN: USXXAM
- DTPatent
- LΑ English

```
A01N009-36
IC
NCL 071086000
     29-7 (Organometallic and Organometalloidal Compounds)
     Section cross-reference(s): 5
FAN.CNT 4
                                             APPLICATION NO.
     PATENT NO.
                   KIND DATE
                                                               DATE
     ______
                                                               _____
    US 4131448 A 19781226
AT 792975 A 19780215
AT 345864 B 19780815
US 4062669 A 19771213
AT 343135 B 19780510
DK 7600538 A 19760210
DK 142162 B 19800915
DK 142162 C 19810216
DK 7600537 A 19760210
DK 141951 B 19800728
DK 141951 C 19801215
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                                             US 1977-836338
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                                             AT 1975-7929
                                                               19731210
                                             US 1975-613708
                                                               19750915
                                             AT 1975-7931
                                                               19751017
                                             DK 1976-538
                                                               19760210
                                             DK 1976-537
                                                               19760210
     DK 141951
                       С
                             19801215
PRAI US 1972-313706 19721211
US 1975-613708 19750909
     AT 1973-10302
                       19731210
                      19731210
     DK 1973-6678
     The title compds., RO2CCH2N(O)R3CH2P(O)(OR1)(OR2) [I, R1, R2 = H, metal
AΒ
     cation, ammonium; R = R1, lower alkyl; R3 = C1-12 alkyl, allyl,
     cyclohexyl, phenalkyl, phenoxyalkyl] were prepd. by oxidn. of
     RO2CCH2NR3CH2P(O)(OR1)(OR2) with a peroxide. Thus, 0.06 mol
     (HO2CCH2)2NCH2P(O)(OH)2, 100 mL HOAc, and 0.6 g H2SO4 was treated with
     0.21 mol 30% H2O2 over 25 min to give 9.2 g (HO2CCH2)2N(O)CH2P(O)(OH)2
     (II). At 4 lb/acre II killed Canada Thistle, Lambsquarters, Nutsedge, and
     Quackgrass.
ST
     herbicide phosphonomethylglycine oxide; phytotoxicant
     phosphonomethylqlycine oxide; qlycine oxide phosphonomethyl; oxidn
     phosphonomethylglycine
IT
     Herbicides
        (phosphonomethylglycine oxides)
     53792-64-6 53792-66-8 53792-78-2
                                             53792-79-3
IT
                                                            53792-80-6
     53792-81-7
                   53792-82-8
                               53792-83-9 53792-86-2
     RL: BAC (Biological activity or effector, except adverse); BSU (Biological
     study, unclassified); BIOL (Biological study)
        (herbicidal activity of)
IT
     2439-99-8
                 5994-61-6 24569-83-3 53792-88-4 53792-89-5
                                                                        69595-88-6
     RL: RCT (Reactant); RACT (Reactant or reagent)
        (oxidn. of)
                                                53792-69-1P
     53792-63-5P 53792-67-9P 53792-68-0P
                                                               53792-70-4P
ΙT
                                                               53792-75-9P
                                 53792-73-7P
                                                53792-74-8P
                  53792-72-6P
     53792-71-5P
                                 53792-87-3P
                                                               69595-83-1P
                                                69595-82-0P
     53792-76-0P 53792-84-0P
                  69595-85-3P
                                  69595-86-4P 69595-87-5P
                                                                69595-89-7P
     69595-84-2P
     69595-90-0P
                   69595-91-1P
     RL: AGR (Agricultural use); BAC (Biological activity or effector, except
     adverse); BSU (Biological study, unclassified); SPN (Synthetic
     preparation); BIOL (Biological study); PREP (Preparation); USES (Uses)
        (prepn. and herbicidal activity of)
IT
     53792-65-7P
     RL: SPN (Synthetic preparation); PREP (Preparation)
        (prepn. of)
REFERENCE 4
```

82:39571 CA AN

N-Organo-N-phosphonomethylglycine N-oxides and their use in plant growth regulating and phytotoxic preparations

Franz, John E. IN

PA Monsanto Co.

SO Ger. Offen., 68 pp.

CODEN: GWXXBX

DT Patent

LA German

IC C07F; A01N

CC 5-3 (Agrochemicals)

Section cross-reference(s): 29

FAN.CNT 4

| FAN. |               |             | VTND       | DATE     | ז ת ל         | PLICATION NO. | ראשב     |
|------|---------------|-------------|------------|----------|---------------|---------------|----------|
|      | PATENT NO.    |             | KIND       | DATE     | AP1           | PLICATION NO. | DATE     |
| ΡI   | DE            | 2361382     | A1         | 19740612 | DE            | 1973-2361382  | 19731210 |
|      | DE            | 2361382     | B2         | 19800508 |               |               |          |
|      | DÈ            | 2361382     | C3         | 19810212 |               |               |          |
|      | BR            | 7309524     | A0         | 19740829 | BR            | 1973-9524     | 19731204 |
|      | RO            | 67869       | P          | 19810622 |               | 1973-76882    | 19731204 |
|      | NL            | 7316784     | Α          | 19740613 | NL            | 1973-16784    | 19731207 |
|      |               | 173408      | В          | 19830816 |               |               |          |
|      |               | 173408      | С          | 19840116 |               |               |          |
|      | ES            | 421263      | <b>A</b> 1 | 19760616 | ES            | 1973-421263   | 19731207 |
|      | ΒE            | 808448      | A1         | 19740610 | BE            | 1973-138707   | 19731210 |
|      | FR            | 2209770     | A1         | 19740705 | FR            | 1973-43994    | 19731210 |
|      | FR            | 2209770     | B1         | 19781110 |               |               |          |
|      | JΡ            | 49086549    | A2         | 19740819 | JP            | 1973-136936.  | 19731210 |
|      | JΡ            | 52041336    | B4         | 19771018 |               |               |          |
|      | ZA            | 7309372     | Α          | 19741127 | ZA            | 1973-9372     | 19731210 |
|      | DD            | 112598      | С          | 19750420 | DD            | 1973-20175229 | 19731210 |
|      | AU            | 7363435     | A1         | 19750612 | AU            | 1973-63435    | 19731210 |
|      | AT            | 7310302     | Α          | 19760415 | AT            | 1973-10302    | 19731210 |
|      | AT            | 334129      | В          | 19761227 |               |               |          |
|      | СН            | 577784      | Α          | 19760730 | CH            | 1973-17275    | 19731210 |
|      | GB            | 1449875     | Α          | 19760915 | GB            | 1973-57150    | 19731210 |
|      | PL            | 91572       | P          | 19770331 | $\mathtt{PL}$ | 1973-167194   | 19731210 |
|      | $\mathtt{PL}$ | 94192       | P          | 19770730 | $\mathtt{PL}$ | 1973-183652   | 19731210 |
|      | CS            | 179995      | P          | 19771230 | CS            | 1973-8527     | 19731210 |
|      | IL            | 43790       | <b>A</b> 1 | 19771230 | IL            | 1973-43790    | 19731210 |
|      | ΑT            | 792975      | Α          | 19780215 | AT            | 1975-7929     | 19731210 |
|      | AT            | 345864      | В          | 19780815 |               |               | •        |
|      | CA            | 1032174     | <b>A</b> 1 | 19780530 | CA            | 1973-187756   | 19731210 |
|      | SE            | 407804      | В          | 19790423 | SE            | 1973-16612    | 19731210 |
|      | SE            | 407804      | С          | 19790802 |               |               |          |
|      |               | 173367      | P          | 19790428 |               | 1973-M0890    | 19731210 |
|      | DK            | 142056      | В          | 19800818 | DK            | 1973-6678     | 19731210 |
|      | DK            | 142056      | С          | 19810112 |               |               |          |
|      | SU            | 850008      | A3         | 19810723 |               | 1973-1976101  | 19731210 |
|      |               | 651648      | D          | 19790305 |               | 1974-2043771  | 19740715 |
|      |               | 343135      | В          | 19780510 |               | 1975-7931     | 19751017 |
|      |               | 7600538     | Α          | 19760210 | DK            | 1976-538      | 19760210 |
|      |               | 142162      | В          | 19800915 |               |               |          |
|      |               | 142162      | С          | 19810216 |               |               |          |
|      | DK            | 7600537     | Α          | 19760210 | DK            | 1976-537      | 19760210 |
|      |               | 141951      | В          | 19800728 |               |               |          |
|      |               | 141951      | C          | 19801215 |               |               |          |
|      |               | 458382      | A1         | 19781001 |               | 1977-458382   | 19770502 |
|      |               | 7800073     | Α          | 19790704 | SE            | 1978-73       | 19780103 |
|      |               | 436089      | В          | 19841112 |               |               |          |
|      |               | 436089      | С          | 19850221 |               |               |          |
| PRAI |               | 1972-313706 | 19721      |          |               |               |          |
|      |               | 1973-10302  | 19731      |          |               |               |          |
|      | DK            | 1973-6678   | 19731      | 210      |               |               |          |

AB R102CCH2N(O)RCH2P(O)(OR2)(OR3) [I,R = CH2CO2R1, CH2P(O)(OR2)(OR3), or C1-12 alkyl; R1 = H, lower alkyl, or metal; R2 and R3 = H, metal, NH4 or

amine] are plant growth regulators and herbicides. Thus, N-phosphonomethyliminodiacetic acid N-oxide (R = ,CH2CO2H, R1 = R2 = R3 = H) [53792-63-5] at 4.5 kg/ha controlled nutsedge in greenhouse. phosphonomethylglycine oxide herbicide; glycine oxide herbicide ΙT Plant hormones and regulators RL: BIOL (Biological study) (phosphonomethylglycine oxide) IΤ Herbicides (phosphonomethylglycine oxides) ΙT 2439-99-8 5994-61-6 24569-83-3 53792-88-4 53792-89-5 RL: RCT (Reactant); RACT (Reactant or reagent) (oxidn. of) IT53792-77-1 53792-78-2 53792-79-3 53792-80-6 53792-81-7 53792-83-9 53792-84-0 53792-85-1 53792-82-8 53792-87-3 RL: BAC (Biological activity or effector, except adverse); BSU (Biological study, unclassified); BIOL (Biological study) (plant growth regulator activity of) IT53792-86-2P RL: SPN (Synthetic preparation); PREP (Preparation) (prepn. and plant growth regulator activity of) ΙT 53792-69-1P 53792-70-4P 53792-71-5P 53792-72-6P 53792-73-7P 53792-74-8P 53792-75-9P 53792-76-0P RL: SPN (Synthetic preparation); PREP (Preparation) (prepn. and plant-growth regulating activity of) ΙT 53792-63-5P 53792-64-6P 53792-65-7P 53792-66-8P 53792-67-9P RL: SPN (Synthetic preparation); PREP (Preparation) (prepn. and plant-growth regulator activity of) ANSWER 3 OF 4 REGISTRY COPYRIGHT 2003 ACS 53792-80-6 REGISTRY Glycine, N-(carboxymethyl)-N-(phosphonomethyl)-, N-oxide, trisodium salt (9CI) (CA INDEX NAME) OTHER NAMES: N-Phosphonomethyliminodiacetic acid N-oxide trisodium salt C5 H10 N O8 P . 3 Na CA, CAPLUS, IFICDB, IFIPAT, IFIUDB, TOXCENTER, USPATFULL STN Files: CRN (53792-63-5)

$$\begin{array}{c} {\rm o} \\ || \\ {\rm Ho_2C-CH_2-N-CH_2-Co_2H} \\ || \\ {\rm CH_2-Po_3H_2} \end{array}$$

•3 Na

4 REFERENCES IN FILE CA (1957 TO DATE) 4 REFERENCES IN FILE CAPLUS (1957 TO DATE)

### REFERENCE 1

AN 100:187352 CA

- TI N-Organophosphonomethylglycine N-oxides and their use to increase the sucrose content of sugarcane
- IN Franz, John E.
- PA Monsanto Co., USA
- SO U.S., 4 pp. Cont.-in-part of U.S. Ser. No. 6133,707, abandoned. CODEN: USXXAM

```
DT
      Patent
LΑ
     English
      A01N057-00
IC
NCL 071086000
      5-3 (Agrochemical Bioregulators)
FAN.CNT 4
     APPLICATION NO. DATE

US 4435204 A 19840306 US 1980-133379 19800324

AT 792975 A 19780215 AT 1975-7929 19731210

AT 345864 B 19780815

AT 343135 B 19780510 AT 1975-7931 19751017

DK 7600538 A 19760210 DK 1976-538 19760210

DK 142162 B 19800915

DK 142162 C 19810216

DK 7600537 A 19760210 DK 1976-537 19760210

DK 141951 B 19800728

DK 141951 C 19801215

US 1972-313706 19721211
                                                      APPLICATION NO. DATE
      PATENT NO.
                           KIND DATE
PRAI US 1972-313706 19721211
US 1975-613707 19750915
      AT 1973-10302 19731210
      DK 1973-6678
                           19731210
AB
      Phosphonomethylglycine N-oxides, prepd. as described in US 4,062,669,
      increased sucrose [57-50-1] content of sugarcane when applied 2-10 wk
      prior to harvest, at .apprx.0.112-5.6 kg/ha. Examples are:
      N-phosphonomethyliminodiacetic acid N-oxide [53792-63-5],
      N-methyl-N-phosphonomethylglycine N-oxide [53792-84-0], and Et
      N, N-bis (phosphonomethyl) glycine N-oxide [69595-84-2]. These compds.
      increased juice purity percentage and sucrose content (Pol percent cane).
ST
      phosphonomethylglycine oxide sugarcane sucrose
ΙT
      Sugarcane
        (sucrose of, organophosphonomethylglycine oxides increase of)
IT
      57-50-1, biological studies
      RL: BIOL (Biological study)
         (of sugarcane, organophosphonomethylglycine oxides increase of)
      24569-83-3 53792-63-5 53792-64-6 53792-65-7 53792-66-8 53792-67-9 53792-68-0 53792-69-1 53792-70-4 53792-71-5 53792-73-7 53792-75-9 53792-76-0 53792-79-3 53792-80-6 53792-82-8 53792-84-0 53792-86-2 69595-83-1 69595-84-2 69595-86-4 69595-87-5 90041-38-6 90041-39-7 90041-40-0
IT
      90041-41-1
      RL: BIOL (Biological study)
          (sucrose content increase by, in sugarcane)
REFERENCE 2
      90:138024 CA
AN
      \hbox{N-Organo-N-phosphonomethylglycine N-oxides and phytotoxicant compositions}
      containing them
IN
      Franz, John E.
PΑ
      Monsanto Co., USA
      U.S., 11 pp. Cont.-in-part of U.S. 4,062,669.
      CODEN: USXXAM
DT
      Patent
LA
      English
IC
      A01N009-36
NCL 071086000
      29-7 (Organometallic and Organometalloidal Compounds)
      Section cross-reference(s): 5
FAN.CNT 4
      APPLICATION NO. DATE
      PATENT NO.
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PΙ
    US 4130412
                      Α
                           19781219
                                         US 1977-836187
                                                          19770926
                      Α
                          19780215
     AT 792975
                                         AT 1975-7929
                                                          19731210
     AT 345864
                     B 19780815
     US 4062669
                     A 19771213
                                         US 1975-613708
                                                         19750915
     AT 343135
                     B 19780510
                                         AT 1975-7931
                                                          19751017
     DK 7600538
                     A 19760210
                                         DK 1976-538
                                                          19760210
     DK 142162
                     B 19800915
                     C 19810216
     DK 142162
     DK 7600537
                     A 19760210
                                         DK 1976-537
                                                          19760210
     DK 141951
                     В 19800728
     DK 141951
                     С
                          19801215
PRAI US 1972-313706 19721211
     US 1975-613708 19750909
     AT 1973-10302
                    19731210
     DK 1973-6678
                     19731210
AB
     The title compds. RO2CCH2N(O)R3CH2P(O)(OR1)(OR2) [I, R1, R2 = H, metal
     cation, ammonium; R, R1 = alkyl; R3 = CnH2nCO2R, n = 1-10] were prepd. by
     oxidn. of RO2CCH2NR3CH2P(O)(OR1)(OR2) with per acids. Thus, 0.06 mol
     [HO2CCH2]2NCH2P(O)(OH)2, 100 mL. HOAc, and 0.6 g H2SO4 was treated with
     0.21 mol H2O2 at 75-80.degree. to give 9.2 g [HO2CCH2]2N(O)CH2P(O)(OH)2
     (II). At 4 lb/acre II gave 100% kill of Canada Thistle, Lambsquarters,
     Nutsedge, and Quackgrass.
st
     herbicide phosphonomethylglycine oxide; phytotoxicant
     phosphonomethylglycine oxide; oxidn phosphonomethylglycine; glycine
     phosphonomethyl oxide
IT
    Herbicides
        (phosphonomethylglycine oxides)
     53792-64-6 53792-66-8 53792-78-2
ΙT
                                          53792-79-3
                                                       53792-80-6
                 53792-82-8
     53792-81-7
                             53792-83-9
     RL: BAC (Biological activity or effector, except adverse); BSU (Biological
     study, unclassified); BIOL (Biological study)
        (herbicidal activity of)
IT
     2439-99-8 5994-61-6 24569-83-3 53792-88-4 53792-89-5
                                                                 69595-88-6
     RL: RCT (Reactant); RACT (Reactant or reagent)
        (oxidn. of)
IT
     53792-63-5P
                 53792-67-9P
                                53792-68-0P
                                             53792-69-1P
                                                           53792-70-4P
     53792-71-5P
                  53792-72-6P
                                53792-74-8P
                                             53792-75-9P
                                                           53792-76-0P
     53792-84-0P
                  53792-86-2P
                                             69595-83-1P
                                69595-82-0P
                                                           69595-84-2P
     69595-85-3P
                  69595-86-4P
                               69595-87-5P
     RL: AGR (Agricultural use); BAC (Biological activity or effector, except
     adverse); BSU (Biological study, unclassified); SPN (Synthetic
     preparation); BIOL (Biological study); PREP (Preparation); USES (Uses)
        (prepn. and herbicidal activity of)
IT
     53792-65-7P 53792-73-7P
     RL: SPN (Synthetic preparation); PREP (Preparation)
        (prepn. of)
REFERENCE 3
ΑN
TI
    N-Organo-N-phosphonomethylglycine-N-oxides and phytotoxicant compositions
     containing them
IN
     Franz, John E.
    Monsanto Co., USA
PA
SO
    U.S., 11 pp. Cont.-in-part of U.S. 4,062,669.
    CODEN: USXXAM
DT
    Patent
LA
    English
    A01N009-36
IC
NCL 071086000
CC
    29-7 (Organometallic and Organometalloidal Compounds)
     Section cross-reference(s): 5
```

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FAN.CNT 4
                                          APPLICATION NO. DATE
                   KIND DATE
     PATENT NO.
     _____
                                            _____
                                                             -----
    US 4131448 A 19781226
AT 792975 A 19780215
AT 345864 B 19780815
US 4062669 A 19771213
AT 343135 B 19780510
DK 7600538 A 19760210
DK 142162 B 19800915
DK 142162 C 19810216
DK 7600537 A 19760210
                                           US 1977-836338
                                                              19770926
PΙ
                                            AT 1975-7929
                                                             19731210
                                            US 1975-613708
                                                              19750915
                                            AT 1975-7931
                                                              19751017
                                            DK 1976-538
                                                              19760210
    DK 7600537 A 19760210
DK 141951 B 19800728
                                            DK 1976-537
                                                             19760210
     DK 141951
                       С
                            19801215
PRAI US 1972-313706 19721211
     US 1975-613708 19750909
     AT 1973-10302
                      19731210
                     19731210
     DK 1973-6678
     The title compds., RO2CCH2N(O)R3CH2P(O)(OR1)(OR2) [I, R1, R2 = H, metal
AΒ
     cation, ammonium; R = R1, lower alkyl; R3 = C1-12 alkyl, allyl,
     cyclohexyl, phenalkyl, phenoxyalkyl] were prepd. by oxidn. of
     RO2CCH2NR3CH2P(O)(OR1)(OR2) with a peroxide. Thus, 0.06 mol
     (HO2CCH2)2NCH2P(O)(OH)2, 100 mL HOAc, and 0.6 g H2SO4 was treated with
     0.21 mol 30% H2O2 over 25 min to give 9.2 g (HO2CCH2)2N(O)CH2P(O)(OH)2
     (II). At 4 lb/acre II killed Canada Thistle, Lambsquarters, Nutsedge, and
     Quackgrass.
ST
     herbicide phosphonomethylglycine oxide; phytotoxicant
     phosphonomethylqlycine oxide; qlycine oxide phosphonomethyl; oxidn
     phosphonomethylglycine
ΙT
     Herbicides
        (phosphonomethylglycine oxides)
     53792-64-6 53792-66-8 53792-78-2
                                             53792-79-3
                                                          53792-80-6
IT
                              53792-83-9
                                            53792-86-2
     53792-81-7
                  53792-82-8
     RL: BAC (Biological activity or effector, except adverse); BSU (Biological
     study, unclassified); BIOL (Biological study)
        (herbicidal activity of)
                 5994-61-6 24569-83-3 53792-88-4 53792-89-5
                                                                      69595-88-6
ΙT
     2439-99-8
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        (oxidn. of)
                                53792-68-0P
                                               53792-69-1P
                                                              53792-70-4P
     53792-63-5P 53792-67-9P
TΨ
                                53792-73-7P
                                               53792-74-8P
     53792-71-5P 53792-72-6P
                                                              53792-75-9P
     53792-76-0P 53792-84-0P 53792-87-3P
                                                69595-82-0P
                                                              69595-83-1P
                                 69595-86-4P 69595-87-5P
                                                              69595-89-7P
     69595-84-2P 69595-85-3P
     69595-90-0P
                   69595-91-1P
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     adverse); BSU (Biological study, unclassified); SPN (Synthetic
     preparation); BIOL (Biological study); PREP (Preparation); USES (Uses)
        (prepn. and herbicidal activity of)
     53792-65-7P
IT
     RL: SPN (Synthetic preparation); PREP (Preparation)
        (prepn. of)
REFERENCE 4
     82:39571 CA
AN
     N-Organo-N-phosphonomethylglycine N-oxides and their use in plant growth
```

- regulating and phytotoxic preparations
- INFranz, John E.
- PΑ Monsanto Co.
- Ger. Offen., 68 pp. CODEN: GWXXBX
- DTPatent

LA German

IC CO7F; A01N

CC 5-3 (Agrochemicals)

Section cross-reference(s): 29

| FAN. | . CNT | 4 |
|------|-------|---|

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|------|---|------------|----------------|-----------|---|-------------|
|      | PATENT NO.  | KIND       | DATE           | AP        | PLICATION NO.   | DATE        |
| ΡI   | DE 2361382  | A1         | 19740612       | חבר       | 1973-2361382  | 19731210    |
| LT   | DE 2361382  | B2         | 19800508       | DE        | 19/3-2301302  | 19/31210    |
|      | DE 2361382  | C3         | 19810212       |           |   |             |
|      |   |            |                | חם        | 1072.0524   | 10721204    |
|      | BR 7309524  | A0         | 19740829       |           | 1973-9524<br>1973-76882   | 19731204    |
|      | RO 67869  | P          | 19810622       |           |   | 19731204    |
|      | NL 7316784  | A          | 19740613       | ИТ        | 1973-16784  | 19731207    |
|      | NL 173408   | В          | 19830816       |           |   |             |
|      | NL 173408   | C          | 19840116       | П.        | 1072 401062   | 10701007    |
|      | ES 421263   | A1         | 19760616       |           | 1973-421263   | 19731207    |
|      | BE 808448   | A1         | 19740610       |           | 1973-138707   | 19731210    |
|      | FR 2209770  | A1         | 19740705       | FR        | 1973-43994  | 19731210    |
|      | FR 2209770  | B1         | 19781110       |           | 1050 106006   | 10701010    |
|      | JP 49086549   | A2         | 19740819       | JP        | 1973-136936   | 19731210    |
|      | JP 52041336   | B4         | 19771018       |           | 4000 0000   |             |
|      | ZA 7309372  | Α          | 19741127       |           | 1973-9372   | 19731210    |
|      | DD 112598   | С          | 19750420       |           | 1973-20175229   |             |
|      | AU 7363435  | <b>A</b> 1 | 19750612       |           | 1973-63435  | 19731210    |
|      | AT 7310302  | A          | 19760415       | TA        | 1973-10302  | 19731210    |
|      | AT 334129   | В          | 19761227       |           |   |             |
|      | CH 577784   | A          | 19760730       |           | 1973-17275  | 19731210    |
|      | GB 1449875  | А          | 19760915       |           | 1973-57150  | 19731210    |
|      | PL 91572  | P          | 19770331       |           | 1973-167194   | 19731210    |
|      | PL 94192  | P          | 19770730       |           | 1973-183652   | 19731210    |
|      | CS 179995   | P          | 19771230       | -         | 1973-8527   | 19731210    |
|      | IL 43790  | A1         | 19771230       | ${	t IL}$ | 1973-43790  | 19731210    |
|      | AT 792975   | Α          | 19780215       | ΑT        | 1975-7929   | 19731210    |
|      | AT 345864   | В          | 19780815       |           |   |             |
|      | CA 1032174  | A1         | 19780530       | CA        | 1973-187756   | 19731210    |
|      | SE 407804   | В          | 19790423       | SE        | 1973-16612  | 19731210    |
|      | SE 407804   | С          | 19790802       |           |   |             |
|      | HU 173367   | P          | 19790428       | HU        | 1973-M0890  | 19731210    |
|      | DK 142056   | В          | 19800818       | DK        | 1973-6678   | 19731210    |
|      | DK 142056   | С          | 19810112       |           |   |             |
|      | SU 850008   | <b>A</b> 3 | 19810723       | SU        | 1973-1976101  | 19731210    |
|      | SU 651648   | D          | 19790305       | SU        | 1974-2043771  | 19740715    |
|      | AT 343135   | В          | 19780510       | ΑT        | 1975-7931   | 19751017    |
|      | DK 7600538  | Α          | 19760210       | DK        | 1976-538  | 19760210    |
|      | DK 142162   | В          | 19800915       |           |   |             |
|      | DK 142162   | С          | 19810216       |           |   |             |
|      | DK 7600537  | Α          | 19760210       | DK        | 1976-537  | 19760210    |
|      | DK 141951   | В          | 19800728       |           |   |             |
|      | DK 141951   | С          | 19801215       |           |   |             |
|      | ES 458382   | A1         | 19781001       | ES        | 1977-458382   | 19770502    |
|      | SE 7800073  | A          | 19790704       |           | 1978-73   | 19780103    |
|      | SE 436089   | В          | 19841112       |           | -   |             |
|      | SE 436089   | c          | 19850221       |           |   |             |
| PRAT | US 1972-313706  | 19721.     |                |           |   |             |
|      | AT 1973-10302   | 19731      | _ <del>_</del> |           |   |             |
|      | DK 1973-6678  | 19731      |                |           |   |             |
| AB   | R102CCH2N(0)RCH2P(0)(OR2)(OR3) [I,R = CH2CO2R1, CH2P(0)(OR2)(OR3) |            |                |           |   | (OR2) (OR3) |

AB R102CCH2N(O)RCH2P(O)(OR2)(OR3) [I,R = CH2CO2R1, CH2P(O)(OR2)(OR3), or C1-12 alkyl; R1 = H, lower alkyl, or metal; R2 and R3 = H, metal, NH4 or amine] are plant growth regulators and herbicides. Thus, N-phosphonomethyliminodiacetic acid N-oxide (R = ,CH2CO2H, R1 = R2 = R3 = H) [53792-63-5] at 4.5 kg/ha controlled nutsedge in greenhouse.

ST phosphonomethylglycine oxide herbicide; glycine oxide herbicide

```
ΙT
     Plant hormones and regulators
     RL: BIOL (Biological study)
         (phosphonomethylglycine oxide)
ΙT
     Herbicides
         (phosphonomethylglycine oxides)
     2439-99-8
                 5994-61-6 24569-83-3
                                          53792-88-4
                                                       53792-89-5
TΨ
     RL: RCT (Reactant); RACT (Reactant or reagent)
         (oxidn. of)
     53792-77-1 53792-78-2
                                             53792-80-6
IT
                                53792-79-3
                                                           53792-81-7
     53792-82-8
                  53792-83-9 53792-84-0
                                             53792-85-1 53792-87-3
     RL: BAC (Biological activity or effector, except adverse); BSU (Biological
     study, unclassified); BIOL (Biological study)
        (plant growth regulator activity of)
IT
     53792-86-2P
     RL: SPN (Synthetic preparation); PREP (Preparation)
        (prepn. and plant growth regulator activity of)
     53792-68-0P
                   53792-69-1P
                                  53792-70-4P
                                                 53792-71-5P
IT
                                                               53792-72-6P
                   53792-74-8P
                                  53792-75-9P
     53792-73-7P
                                                53792-76-0P
     RL: SPN (Synthetic preparation); PREP (Preparation)
        (prepn. and plant-growth regulating activity of)
IT
     53792-63-5P
                  53792-64-6P
                                53792-65-7P 53792-66-8P
                                                               53792-67-9P
     RL: SPN (Synthetic preparation); PREP (Preparation)
        (prepn. and plant-growth regulator activity of)
L5
     ANSWER 4 OF 4 REGISTRY COPYRIGHT 2003 ACS
     53792-79-3 REGISTRY
RN
CN
     Glycine, N-(carboxymethyl)-N-(phosphonomethyl)-, N-oxide, disodium salt
     (9CI) (CA INDEX NAME)
OTHER NAMES:
CN
     N-Phosphonomethyliminodiacetic acid N-oxide disodium salt
     \texttt{C5}\ \texttt{H10}\ \texttt{N}\ \texttt{O8}\ \texttt{P} . 2 \texttt{Na}
MF
LC
                  CA, CAPLUS, IFICDB, IFIPAT, IFIUDB, TOXCENTER, USPATFULL
     STN Files:
CRN (53792-63-5)
```

$$\begin{array}{c} \text{O} \\ || \\ \text{HO}_2\text{C} - \text{CH}_2 - \text{N} - \text{CH}_2 - \text{CO}_2\text{H} \\ | \\ \text{CH}_2 - \text{PO}_3\text{H}_2 \end{array}$$

●2 Na

4 REFERENCES IN FILE CA (1957 TO DATE) 4 REFERENCES IN FILE CAPLUS (1957 TO DATE)

### REFERENCE 1

AN 100:187352 CA

 ${\tt TI}$  N-Organophosphonomethylglycine N-oxides and their use to increase the sucrose content of sugarcane

IN Franz, John E.

PA Monsanto Co. , USA

SO U.S., 4 pp. Cont.-in-part of U.S. Ser. No. 6133,707, abandoned. CODEN: USXXAM

DT Patent

LA English

IC A01N057-00

NCL 071086000

```
5-3 (Agrochemical Bioregulators)
FAN.CNT 4
      PATENT NO.
                         KIND DATE
                                                   APPLICATION NO. DATE
     US 4435204 A 19840306 US 1980-133379 19800324
AT 792975 A 19780215 AT 1975-7929 19731210
AT 345864 B 19780510 AT 1975-7931 19751017
DK 7600538 A 19760210 DK 1976-538 19760210
DK 142162 B 19800915
DK 142162 C 19810216
DK 7600537 A 19760210 DK 1976-537 19760210
DK 141951 B 19800728
DK 141951 C 19801215
US 1972-313706 19721211
PΙ
PRAI US 1972-313706 19721211
US 1975-613707 19750915
      AT 1973-10302
                           19731210
      DK 1973-6678
                           19731210
AB
      Phosphonomethylglycine N-oxides, prepd. as described in US 4,062,669,
      increased sucrose [57-50-1] content of sugarcane when applied 2-10 wk prior to harvest, at .apprx.0.112-5.6 kg/ha. Examples are: N-phosphonomethyliminodiacetic acid N-oxide [53792-63-5],
      N-methyl-N-phosphonomethylglycine N-oxide [53792-84-0], and Et
      N, N-bis (phosphonomethyl) glycine N-oxide [69595-84-2]. These compds.
      increased juice purity percentage and sucrose content (Pol percent cane).
ST
      phosphonomethylglycine oxide sugarcane sucrose
      Sugarcane
IT
          (sucrose of, organophosphonomethylglycine oxides increase of)
      57-50-1, biological studies
ΙT
      RL: BIOL (Biological study)
          (of sugarcane, organophosphonomethylglycine oxides increase of)
TΤ
      24569-83-3 53792-63-5 53792-64-6 53792-65-7 53792-66-8
      53792-67-9 53792-68-0 53792-69-1 53792-70-4 53792-71-5
      53792-73-7 53792-75-9 53792-76-0 53792-79-3 53792-80-6
      53792-82-8 53792-84-0 53792-86-2 69595-83-1 69595-84-2
      69595-86-4 69595-87-5 90041-38-6 90041-39-7 90041-40-0
      90041-41-1
      RL: BIOL (Biological study)
          (sucrose content increase by, in sugarcane)
REFERENCE 2
ΑN
      90:138024 CA
      \hbox{N-Organo-N-phosphonomethylglycine N-oxides and phytotoxicant compositions}
TΤ
      containing them
IN
      Franz, John E.
      Monsanto Co., USA
PA
so
      U.S., 11 pp. Cont.-in-part of U.S. 4,062,669.
      CODEN: USXXAM
TT
      Patent
LΑ
      English
IC
      A01N009-36
NCL
     071086000
      29-7 (Organometallic and Organometalloidal Compounds)
      Section cross-reference(s): 5
FAN.CNT 4
                          KIND DATE APPLICATION NO. DATE
      PATENT NO. KIND DATE
                                                    -----
     US 4130412 A 19781219 US 1977-836187 19770926
AT 792975 A 19780215 AT 1975-7929 19731210
AT 345864 B 19780815
US 4062669 A 19771213 US 1975-613708 19750915
```

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AT 343135 B 19780510
DK 7600538 A 19760210
DK 142162 B 19800915
DK 142162 C 19810216
DK 7600537 A 19760210
DK 141951 B 19800728
DK 141951 C 19801215
                                                  AT 1975-7931
                                                                       19751017
                                                  DK 1976-538
                                                                       19760210
                                                 DK 1976-537 19760210
PRAI US 1972-313706 19721211
US 1975-613708 19750909
     AT 1973-10302 19731210
DK 1973-6678 19731210
      The title compds. RO2CCH2N(O)R3CH2P(O)(OR1)(OR2) [I, R1, R2 = H, metal
AB
      cation, ammonium; R, R1 = alkyl; R3 = CnH2nCO2R, n = 1-10] were prepd. by
      oxidn. of RO2CCH2NR3CH2P(O)(OR1)(OR2) with per acids. Thus, 0.06 mol
      [HO2CCH2]2NCH2P(O)(OH)2, 100 mL. HOAc, and 0.6 g H2SO4 was treated with
      0.21 mol H2O2 at 75-80.degree. to give 9.2 g [HO2CCH2]2N(O)CH2P(O)(OH)2
      (II). At 4 lb/acre II gave 100% kill of Canada Thistle, Lambsquarters,
     Nutsedge, and Quackgrass.
ST
      herbicide phosphonomethylglycine oxide; phytotoxicant
      phosphonomethylglycine oxide; oxidn phosphonomethylglycine; glycine
     phosphonomethyl oxide
IT
     Herbicides
        (phosphonomethylglycine oxides)
ΙT
      53792-64-6 53792-66-8 53792-78-2
                                                   53792-79-3 53792-80-6
      53792-81-7
                     53792-82-8
                                   53792-83-9
      RL: BAC (Biological activity or effector, except adverse); BSU (Biological
      study, unclassified); BIOL (Biological study)
         (herbicidal activity of)
                  5994-61-6 24569-83-3 53792-88-4 53792-89-5 69595-88-6
IT
      2439-99-8
      RL: RCT (Reactant); RACT (Reactant or reagent)
         (oxidn. of)

      53792-63-5P
      53792-67-9P
      53792-68-0P
      53792-69-1P
      53792-70-4P

      53792-71-5P
      53792-72-6P
      53792-74-8P
      53792-75-9P
      53792-76-0P

      53792-84-0P
      53792-86-2P
      69595-82-0P
      69595-83-1P
      69595-84-2P

      69595-85-3P
      69595-86-4P
      69595-87-5P
      69595-87-5P

IT
      RL: AGR (Agricultural use); BAC (Biological activity or effector, except
      adverse); BSU (Biological study, unclassified); SPN (Synthetic
      preparation); BIOL (Biological study); PREP (Preparation); USES (Uses)
          (prepn. and herbicidal activity of)
IT
      53792-65-7P 53792-73-7P
      RL: SPN (Synthetic preparation); PREP (Preparation)
          (prepn. of)
REFERENCE 3
      N-Organo-N-phosphonomethylglycine-N-oxides and phytotoxicant compositions
      containing them
      Franz, John E.
IN
     Monsanto Co., USA
     U.S., 11 pp. Cont.-in-part of U.S. 4,062,669.
     CODEN: USXXAM
DT
     Patent
     English
LA
     A01N009-36
IC
NCL 071086000
      29-7 (Organometallic and Organometalloidal Compounds)
      Section cross-reference(s): 5
FAN.CNT 4
      US 4131448 TABLE APPLICATION NO. DATE
     PATENT NO. KIND DATE
                       A 19781226 US 1977-836338 19770926
PΙ
    US 4131448
```

```
AT 792975
                          19780215
                                         AT 1975-7929
                                                          19731210
    AT 345864
                      В
                          19780815
    US 4062669
                     A 19771213
                                         US 1975-613708
                                                          19750915
    AT 343135
                     B 19780510
                                         AT 1975-7931
                                                          19751017
    DK 7600538
                     A 19760210
                                         DK 1976-538
                                                          19760210
    DK 142162
                     в 19800915
                     C 19810216
    DK 142162
    DK 7600537
                     A 19760210
                                         DK 1976-537
                                                          19760210
                     В 19800728
    DK 141951
    DK 141951
                     С
                          19801215
PRAI US 1972-313706 19721211
    US 1975-613708 19750909
    AT 1973-10302
                     19731210
    DK 1973-6678
                     19731210
    The title compds., RO2CCH2N(O)R3CH2P(O)(OR1)(OR2) [I, R1, R2 = H, metal
AΒ
    cation, ammonium; R = R1, lower alkyl; R3 = C1-12 alkyl, allyl,
    cyclohexyl, phenalkyl, phenoxyalkyl] were prepd. by oxidn. of
    RO2CCH2NR3CH2P(O)(OR1)(OR2) with a peroxide. Thus, 0.06 mol
     (HO2CCH2) 2NCH2P(O) (OH) 2, 100 mL HOAc, and 0.6 g H2SO4 was treated with
    0.21 mol 30% H2O2 over 25 min to give 9.2 g (HO2CCH2)2N(O)CH2P(O)(OH)2
     (II). At 4 lb/acre II killed Canada Thistle, Lambsquarters, Nutsedge, and
    Quackgrass.
ST
    herbicide phosphonomethylglycine oxide; phytotoxicant
    phosphonomethylqlycine oxide; qlycine oxide phosphonomethyl; oxidn
    phosphonomethylglycine
ΙT
    Herbicides
        (phosphonomethylglycine oxides)
                 53792-66-8 53792-78-2
                                                       53792-80-6
IT
    53792-64-6
                                          53792-79-3
                            53792-83-9 53792-86-2
    53792-81-7
                 53792-82-8
    RL: BAC (Biological activity or effector, except adverse); BSU (Biological
    study, unclassified); BIOL (Biological study)
        (herbicidal activity of)
    2439-99-8 5994-61-6 24569-83-3 53792-88-4 53792-89-5
IT
                                                                  69595-88-6
    RL: RCT (Reactant); RACT (Reactant or reagent)
        (oxidn. of)
ΙT
    53792-63-5P
                 53792-67-9P
                                53792-68-0P
                                             53792-69-1P
                                                           53792-70-4P
                 53792-72-6P
                                53792-73-7P
    53792-71-5P
                                             53792-74-8P
                                                           53792-75-9P
                 53792-84-0P
                              53792-87-3P
    53792-76-0P
                                             69595-82-0P
                                                           69595-83-1P
                              69595-86-4P 69595-87-5P
    69595-84-2P
                 69595-85-3P
                                                           69595-89-7P
    69595-90-0P
                 69595-91-1P
    RL: AGR (Agricultural use); BAC (Biological activity or effector, except
    adverse); BSU (Biological study, unclassified); SPN (Synthetic
    preparation); BIOL (Biological study); PREP (Preparation); USES (Uses)
        (prepn. and herbicidal activity of)
TI
    53792-65-7P
    RL: SPN (Synthetic preparation); PREP (Preparation)
        (prepn. of)
REFERENCE 4
    82:39571 CA
    N-Organo-N-phosphonomethylqlycine N-oxides and their use in plant growth
    regulating and phytotoxic preparations
IN
    Franz, John E.
PΑ
    Monsanto Co.
SO
    Ger. Offen., 68 pp.
    CODEN: GWXXBX
DT
    Patent
LA
    German
IC
    C07F; A01N
CC
    5-3 (Agrochemicals)
    Section cross-reference(s): 29
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| FAN.CNT 4 |  |                |                      |            |                         |                      |  |  |
|-----------|--|----------------|----------------------|------------|-------------------------|----------------------|--|--|
|           | PATENT NO.   | KIND           | DATE                 | AP         | PLICATION NO.           | DATE                 |  |  |
| PI        | DE 2361382   | A1             | 19740612             | DE         | 1973-2361382            | 19731210             |  |  |
|           | DE 2361382   | В2             | 19800508             |            |                         |                      |  |  |
|           | DE 2361382   | C3             | 19810212             |            |                         |                      |  |  |
|           | BR 7309524   | A0             | 19740829             | BR         | 1973-9524               | 19731204             |  |  |
|           | RO 67869   | P              | 19810622             | RO         | 1973-76882              | 19731204             |  |  |
|           | NL 7316784   | Α              | 19740613             | $N\Gamma$  | 1973-16784              | 19731207             |  |  |
|           | NL 173408  | В              | 19830816             |            |                         |                      |  |  |
|           | NL 173408  | C              | 19840116             |            |                         |                      |  |  |
|           | ES 421263  | A1             | 19760616             |            | 1973-421263             | 19731207             |  |  |
|           | BE 808448  | A1             | 19740610             |            | 1973-138707             | 19731210             |  |  |
|           | FR 2209770   | A1             | 19740705             | FR         | 1973-43994              | 19731210             |  |  |
|           | FR 2209770   | B1             | 19781110             | TD         | 1973-136936             | 10731310             |  |  |
|           | JP 49086549<br>JP 52041336   | A2<br>B4       | 19740819<br>19771018 | υP         | 19/3-130930             | 19731210             |  |  |
|           | ZA 7309372   | A<br>A         | 19741127             | 77         | 1973-9372               | 19731210             |  |  |
|           | DD 112598  | C              | 19750420             |            | 1973-20175229           |                      |  |  |
|           | AU 7363435   | A1             | 19750420             |            | 1973-63435              | 19731210             |  |  |
|           | AT 7310302   | A              | 19760415             |            | 1973-10302              | 19731210             |  |  |
|           | AT 334129  | В              | 19761227             | 211        | 1373 10302              | 19731210             |  |  |
|           | CH 577784  | A              | 19760730             | СН         | 1973-17275              | 19731210             |  |  |
|           | GB 1449875   | A              | 19760915             |            | 1973-57150              | 19731210             |  |  |
|           | PL 91572   | P              | 19770331             |            | 1973-167194             | 19731210             |  |  |
|           | PL 94192   | P              | 19770730             |            | 1973-183652             | 19731210             |  |  |
|           | CS 179995  | P              | 19771230             |            | 1973-8527               | 19731210             |  |  |
|           | IL 43790   | A1             | 19771230             | $_{	t IL}$ | 1973-43790              | 19731210             |  |  |
|           | AT 792975  | Α              | 19780215             | ΑT         | 1975-7929               | 19731210             |  |  |
|           | AT 345864  | В              | 19780815             |            |                         |                      |  |  |
|           | CA 1032174   | A1             | 19780530             |            | 1973-187756             | 19731210             |  |  |
|           | SE 407804  | В              | 19790423             | SE         | 1973-16612              | 19731210             |  |  |
|           | SE 407804  | С              | 19790802             | ****       | 1072 MO000              | 10721210             |  |  |
|           | HU 173367  | P<br>B         | 19790428             |            | 1973-MO890<br>1973-6678 | 19731210<br>19731210 |  |  |
|           | DK 142056<br>DK 142056   | C              | 19800818<br>19810112 | DΚ         | 19/3-00/0               | 19731210             |  |  |
|           | SU 850008  | A3             | 19810723             | SII        | 1973-1976101            | 19731210             |  |  |
|           | SU 651648  | D              | 19790305             |            | 1974-2043771            | 19740715             |  |  |
|           | AT 343135  | В              | 19780510             |            | 1975-7931               | 19751017             |  |  |
|           | DK 7600538   | A              | 19760210             |            | 1976-538                | 19760210             |  |  |
|           | DK 142162  | В              | 19800915             |            |                         |                      |  |  |
|           | DK 142162  | С              | 19810216             |            |                         |                      |  |  |
|           | DK 7600537   | Α              | 19760210             | DK         | 1976-537                | 19760210             |  |  |
|           | DK 141951  | В              | 19800728             |            |                         |                      |  |  |
|           | DK 141951  | С              | 19801215             |            |                         |                      |  |  |
|           | ES 458382  | A1             | 19781001             |            | 1977-458382             | 19770502             |  |  |
|           | SE 7800073   | A              | 19790704             | SE         | 1978-73                 | 19780103             |  |  |
|           | SE 436089  | В              | 19841112             |            |                         |                      |  |  |
|           | SE 436089  | C              | 19850221             |            |                         |                      |  |  |
| PRAI      | US 1972-313706   | 19721          |                      |            |                         |                      |  |  |
|           | AT 1973-10302<br>DK 1973-6678  | 19731<br>19731 |                      |            |                         |                      |  |  |
| AB        | R102CCH2N(O)RCH2   |                |                      | CH.        | 2CO2D1 CH2D/O           | 1 (OP2) (OP3) or     |  |  |
| AD        |  |                |                      |            |                         | = H, metal, NH4 or   |  |  |
|           |  |                |                      |            |                         | us,                  |  |  |
|           | amine] are plant growth regulators and herbicides. Thus, $N-phosphonomethyliminodiacetic acid N-oxide (R = ,CH2CO2H, R1 = R2 = R3$ |                |                      |            |                         |                      |  |  |
|           | H) [53792-63-5] at 4.5 kg/ha controlled nutsedge in greenhouse.  |                |                      |            |                         |                      |  |  |
| ST        | phosphonomethylg   |                |                      |            |                         |                      |  |  |
| IT        | Plant hormones a   | nd reg         | ulators              |            |                         |                      |  |  |
|           | RL: BIOL (Biological study)  |                |                      |            |                         |                      |  |  |
|           | (phosphonomethylglycine oxide)   |                |                      |            |                         |                      |  |  |
| IT        | Herbicides   |                |                      |            |                         |                      |  |  |
|           |  |                |                      |            |                         |                      |  |  |

```
(phosphonomethylglycine oxides)
               5994-61-6 24569-83-3
IT
     2439-99-8
                                         53792-88-4
                                                       53792-89-5
     RL: RCT (Reactant); RACT (Reactant or reagent)
        (oxidn. of)
     53792-77-1
                53792-78-2
                              53792-79-3
                                           53792-80-6
                                                        53792-81-7
IT
                                          53792-85-1 53792-87-3
     53792-82-8
                 53792-83-9 53792-84-0
     RL: BAC (Biological activity or effector, except adverse); BSU (Biological
     study, unclassified); BIOL (Biological study)
        (plant growth regulator activity of)
     53792-86-2P
TΤ
     RL: SPN (Synthetic preparation); PREP (Preparation)
        (prepn. and plant growth regulator activity of)
     53792-68-0P
                  53792-69-1P
                               53792-70-4P
                                              53792-71-5P
                                                             53792-72-6P
IT
     53792-73-7P
                  53792-74-8P
                                53792-75-9P
                                              53792-76-0P
     RL: SPN (Synthetic preparation); PREP (Preparation)
        (prepn. and plant-growth regulating activity of)
IT
     53792-63-5P
                 53792-64-6P 53792-65-7P
                                             53792-66-8P
                                                            53792-67-9P
     RL: SPN (Synthetic preparation); PREP (Preparation)
        (prepn. and plant-growth regulator activity of)
=> d his
     (FILE 'HOME' ENTERED AT 12:01:33 ON 12 MAY 2003)
     FILE 'REGISTRY' ENTERED AT 12:02:16 ON 12 MAY 2003
               E PHOSPHONOMETHYLIMINODIACETIC ACID/CN
             0 S E3
L1
               E N-PHOSPHONOMETHYLIMINODIACETIC ACID/CN
               E N-PHOSPHONOMETHYLIMINODIACETIC/CN
               E PHOSPHONOMETHYLIMINODIACETIC/CN
             0 S E3
L2
               E N-PHOSPHONOMETHYLIMINODIACETIC ACID/CN
L3
             0 S E3
               E ACETODISPHONIC ACID/CN
               E METHYLAMINO DIMETHYLENE PHOSPHONIC ACID/CN
             1 S PHOSPHONOMETHYLIMINOACETIC ACID/CN
L4
               E N-PHOSPHONOMETHYLIMINODIACETIC ACID/CN
     FILE 'REGISTRY' ENTERED AT 12:32:32 ON 12 MAY 2003
               E N-PHOSPHONOMETHYLIMINODIACETIC ACID/CN
             4 S N-PHOSPHONOMETHYLIMINODIACETIC ACID
L5
```

(FILE 'HOME' ENTERED AT 14:06:09 ON 12 MAY 2003)

FILE 'REGISTRY' ENTERED AT 14:07:01 ON 12 MAY 2003

STRUCTURE UPLOADED

5 S L1

FILE 'CAPLUS' ENTERED AT 14:07:26 ON 12 MAY 2003

6 S L2

272856 S CMP OR ?POLISH? OR CHEMIPOLISH? OR CHEMIMECH? OR PLANARIZ? OR

0 S L3 AND L4

=>

COOH

CH2

COOH

Structure in drawn men searchin caping

```
ANSWER 1 OF 6 CAPLUS COPYRIGHT 2003 ACS
L3
IT
     475095-29-5
     RL: PRP (Properties)
       (crystal structure of)
RN
     475095-29-5 CAPLUS
CN
     Glycine, N-(carboxymethyl)-N-(phosphonomethyl)-, compd. with
     1,4-diazabicyclo[2.2.2]octane, hydrate (2:2:3) (9CI) (CA INDEX NAME)
     CM
          1
     CRN 5994-61-6
     CMF C5 H10 N O7 P
          CH2-РО3Н2
HO_2C-CH_2-N-CH_2-CO_2H
     CM
          2
     CRN 280-57-9
     CMF C6 H12 N2
L3
    ANSWER 2 OF 6 CAPLUS COPYRIGHT 2003 ACS
ΙT
     87753-63-7
     RL: RCT (Reactant); RACT (Reactant or reagent)
       (oxidn. of)
RN
     87753-63-7 CAPLUS
     Glycine, N-(carboxymethyl)-N-(phosphonomethyl)-, compd. with
     N, N'-diphenylguanidine (1:1) (9CI) (CA INDEX NAME)
     CM
          1
     CRN 5994-61-6
     CMF C5 H10 N O7 P
          CH2-PO3H2
HO_2C-CH_2-N-CH_2-CO_2H
     CM
          2
     CRN 102-06-7
     CMF C13 H13 N3
```

 $. \Rightarrow d 13 hitstr 1-6$ 

PhNH-C-NHPh ANSWER 3 OF 6 CAPLUS COPYRIGHT 2003 ACS L3 87753-63-7 ΙT RL: RCT (Reactant); RACT (Reactant or reagent) (oxidn. of) 87753-63-7 CAPLUS RN CNGlycine, N-(carboxymethyl)-N-(phosphonomethyl)-, compd. with N,N'-diphenylguanidine (1:1) (9CI) (CA INDEX NAME) CM CRN 5994-61-6 CMF C5 H10 N O7 P сн<sub>2</sub>- Розн<sub>2</sub>  $HO_2C-CH_2-N-CH_2-CO_2H$ CM 2 CRN 102-06-7 CMF C13 H13 N3 NH PhNH-C-NHPh L3ANSWER 4 OF 6 CAPLUS COPYRIGHT 2003 ACS IT 81851-98-1 RL: PRP (Properties) (IR, NMR and photoelectron spectra of) 81851-98-1 CAPLUS RN CNGlycine, N-(carboxymethyl)-N-(phosphonomethyl)-, labeled with deuterium, tripotassium salt (9CI) (CA INDEX NAME) CH2- PO3H2 HO2C-CH2-N-CH2-CO2H

●3 K

L3 ANSWER 5 OF 6 CAPLUS COPYRIGHT 2003 ACS ΙT 70241-53-1DP, zinc-potassium complex RL: SPN (Synthetic preparation); PREP (Preparation) (prepn. of) 70241-53-1 CAPLUS RN

• CN Glycine, N-(carboxymethyl)-N-(1,1-diphosphonopropyl)- (9CI) (CA INDEX NAME)

$$\begin{array}{c} & \text{PO}_{3}\text{H}_{2} \\ | & \\ \text{HO}_{2}\text{C} - \text{CH}_{2} - \text{N} - - \text{C} - \text{Et} \\ | & \\ | & \\ \text{HO}_{2}\text{C} - \text{CH}_{2} \text{ PO}_{3}\text{H}_{2} \end{array}$$

L3 ANSWER 6 OF 6 CAPLUS COPYRIGHT 2003 ACS

IT 59726-67-9

RL: BIOL (Biological study)

(Kentucky bluegrass turf growth suppression by)

RN 59726-67-9 CAPLUS

CN Glycine, N-(carboxymethyl)-N-(phosphonomethyl)-, diammonium salt (9CI) (CA INDEX NAME)

$$\begin{array}{c} {\rm CH_2-PO_3H_2} \\ | \\ {\rm HO_2C-CH_2-N-CH_2-CO_2H} \end{array}$$

●2 NH3

(FILE 'HOME' ENTERED AT 14:00:37 ON 12 MAY 2003)

FILE 'REGISTRY' ENTERED AT 14:00:42 ON 12 MAY 2003 STRUCTURE UPLOADED

L2 8 S L1

FILE 'CAPLUS' ENTERED AT 14:01:11 ON 12 MAY 2003

L3 11 S L2

L4 183547 S CMP OR ?POLISH? OR CHEMIPOLISH? OR CHEMIMECH? OR PLANARIZ? OR

L5 0 S L3 AND L4

=>

L1

PO3 Ha-(CH2) n-N CH2-R3

R', R2 = 108 -P63 H2 -COOH

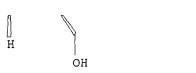
=> d hitstr L3 ANSWER 1 OF 11 CAPLUS COPYRIGHT 2003 ACS IT 475095-29-5 RL: PRP (Properties) (crystal structure of) RN 475095-29-5 CAPLUS Glycine, N-(carboxymethyl)-N-(phosphonomethyl)-, compd. with CN1,4-diazabicyclo[2.2.2]octane, hydrate (2:2:3) (9CI) (CA INDEX NAME) CM CRN 5994-61-6 CMF C5 H10 N O7 P CH2-PO3H2  $HO_2C-CH_2-N-CH_2-CO_2H$ CM2 CRN 280-57-9 CMF C6 H12 N2 => d hitstr 2-11 ANSWER 2 OF 11 CAPLUS COPYRIGHT 2003 ACS L3ΙT 334869-24-8 RL: PRP (Properties) (creation of polymer films with novel structures and properties by processing with inclusion compds.) 334869-24-8 CAPLUS RN CN .beta.-Cyclodextrin, compd. with hexaammonium [nitrilotris(methylene)]tris[phosphonate] (9CI) (CA INDEX NAME) CM 1 CRN 94021-28-0 CMF C3 H12 N O9 P3 . 6 H3 N CH2-PO3H2 H2O3P-CH2-N-CH2-PO3H2

CM 2

CRN 7585-39-9 CMF C42 H70 O35

Absolute stereochemistry.

PAGE 1-A



PAGE 2-A

L3 ANSWER 3 OF 11 CAPLUS COPYRIGHT 2003 ACS

IT 334869-24-8

RL: MOA (Modifier or additive use); USES (Uses)
 (flame retardant; creation of novel polymer materials by processing
 with inclusion compds.)

RN 334869-24-8 CAPLUS

CN .beta.-Cyclodextrin, compd. with hexaammonium [nitrilotris(methylene)]tris[phosphonate] (9CI) (CA INDEX NAME)

CM 1

CRN 94021-28-0

CMF C3 H12 N O9 P3 . 6 H3 N

$$\begin{array}{c} \text{CH}_2-\text{PO}_3\text{H}_2 \\ | \\ \text{H}_2\text{O}_3\text{P}-\text{CH}_2-\text{N}-\text{CH}_2-\text{PO}_3\text{H}_2 \end{array}$$

●6 NH3

CM 2

CRN 7585-39-9 CMF C42 H70 O35

Absolute stereochemistry.

PAGE 1-A

PAGE 2-A

- L3 ANSWER 4 OF 11 CAPLUS COPYRIGHT 2003 ACS
- IT 334869-24-8

RL: MOA (Modifier or additive use); PRP (Properties); USES (Uses) (flame retardant; flame retardant-cyclodextrin inclusion compd. for poly(ethylene terephthalate))

RN 334869-24-8 CAPLUS

CN .beta.-Cyclodextrin, compd. with hexaammonium [nitrilotris(methylene)]tris[phosphonate] (9CI) (CA INDEX NAME)

CM 1

CRN 94021-28-0 CMF C3 H12 N O9 P3 . 6 H3 N

$$\begin{array}{c} \text{CH}_2\text{--PO}_3\text{H}_2 \\ | \\ \text{H}_2\text{O}_3\text{P}-\text{CH}_2-\text{N}-\text{CH}_2-\text{PO}_3\text{H}_2 \end{array}$$

●6 NH3

CM 2

L3

CRN 7585-39-9 CMF C42 H70 O35

Absolute stereochemistry.

PAGE 1-A

PAGE 2-A



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ΙT
     87753-63-7
     RL: RCT (Reactant); RACT (Reactant or reagent)
         (oxidn. of)
     87753-63-7 CAPLUS
RN
     Glycine, N-(carboxymethyl)-N-(phosphonomethyl)-, compd. with N,N'-diphenylguanidine (1:1) (9CI) (CA INDEX NAME)
CN
     CM
           1
     CRN 5994-61-6
     CMF C5 H10 N O7 P
           CH2-PO3H2
HO2C-CH2-N-CH2-CO2H
     CM
          2
     CRN 102-06-7
     CMF C13 H13 N3
      NH
PhNH-C-NHPh
L3
     ANSWER 6 OF 11 CAPLUS COPYRIGHT 2003 ACS
IT
     87753-63-7
     RL: RCT (Reactant); RACT (Reactant or reagent)
         (oxidn. of)
     87753-63-7 CAPLUS
RN
     Glycine, N-(carboxymethyl)-N-(phosphonomethyl)-, compd. with
     N,N'-diphenylguanidine (1:1) (9CI) (CA INDEX NAME)
     CM
     CRN 5994-61-6
     CMF C5 H10 N O7 P
           CH2-PO3H2
HO2C-CH2-N-CH2-CO2H
     СМ
          2
     CRN 102-06-7
     CMF C13 H13 N3
     NH
PhNH-C-NHPh
```

•L3 ANSWER 7 OF 11 CAPLUS COPYRIGHT 2003 ACS

IT 81851-98-1

RL: PRP (Properties)

(IR, NMR and photoelectron spectra of)

- RN 81851-98-1 CAPLUS
- CN Glycine, N-(carboxymethyl)-N-(phosphonomethyl)-, labeled with deuterium, tripotassium salt (9CI) (CA INDEX NAME)

$$\begin{array}{c} \text{CH}_2-\text{PO}_3\text{H}_2 \\ | \\ \text{HO}_2\text{C}-\text{CH}_2-\text{N}-\text{CH}_2-\text{CO}_2\text{H} \end{array}$$

●3 K

- L3 ANSWER 8 OF 11 CAPLUS COPYRIGHT 2003 ACS
- TT 70241-53-1DP, zinc-potassium complex
  RL: SPN (Synthetic preparation); PREP (Preparation)

(prepn. of)
RN 70241-53-1 CAPLUS

CN Glycine, N-(carboxymethyl)-N-(1,1-diphosphonopropyl)- (9CI) (CA INDEX NAME)

$$\begin{array}{c|c} & \text{PO}_3\text{H}_2 \\ & | \\ \text{HO}_2\text{C}-\text{CH}_2-\text{N}--\text{C}-\text{Et} \\ & | \\ & | \\ \text{HO}_2\text{C}-\text{CH}_2 & \text{PO}_3\text{H}_2 \end{array}$$

- L3 ANSWER 9 OF 11 CAPLUS COPYRIGHT 2003 ACS
- IT 59726-67-9

RL: BIOL (Biological study)

(Kentucky bluegrass turf growth suppression by)

- RN 59726-67-9 CAPLUS

$$\begin{array}{c} \text{CH}_2-\text{PO}_3\text{H}_2 \\ | \\ \text{HO}_2\text{C}-\text{CH}_2-\text{N}-\text{CH}_2-\text{CO}_2\text{H} \end{array}$$

●2 NH3

- L3 ANSWER 10 OF 11 CAPLUS COPYRIGHT 2003 ACS
- IT 53584-55-7

RL: PRP (Properties)

(ir spectrum of)

- RN 53584-55-7 CAPLUS
- CN Phosphonic acid, [nitrilotris(methylene)]tris-, labeled with deuterium,

dipotassium salt (9CI) (CA INDEX NAME)

$$\begin{array}{c} \text{CH}_2\text{--PO}_3\text{H}_2 \\ | \\ \text{H}_2\text{O}_3\text{P}-\text{CH}_2-\text{N}-\text{CH}_2-\text{PO}_3\text{H}_2 \end{array}$$

# ●2 K

$$\begin{array}{c} \text{CH}_2\text{--}\text{PO}_3\text{H}_2\\ |\\ \text{H}_2\text{O}_3\text{P}-\text{CH}_2\text{--}\text{N}-\text{CH}_2\text{--}\text{CO}_2\text{H} \end{array}$$

## ● 4 K

CM 2

CRN 7722-84-1 CMF H2 O2

 ${\tt HO-OH}$ 

=> d his

(FILE 'HOME' ENTERED AT 14:00:37 ON 12 MAY 2003)

FILE 'REGISTRY' ENTERED AT 14:00:42 ON 12 MAY 2003

L1 STRUCTURE UPLOADED

L2 8 S L1

FILE 'CAPLUS' ENTERED AT 14:01:11 ON 12 MAY 2003 L3 11 S L2

=> s cmp or ?polish? or chemipolish? or chemimech? or planariz? or lap? or grind? or abrad?

7917 CMP